

# TLT9255WLC

# HS CAN Transceiver with Partial Networking



1 Overview

# ci Inlineon ison.s.

# Features

- Fully compliant to ISO 11898-2 (2016)
- Infineon automotive quality
- AEC-Q100 Grade 0 (Ta: -40°C to +150°C) qualification for high temperature mission profiles
- HS CAN standard data rates up to 1MBit/s
- CAN FD data rates up to 5 MBit/s
- Wide common mode range for electromagnetic immunity (EMI)
- Very low electromagnetic emission (EME)
- Excellent ESD robustness, ±10 kV according to IEC 61000-4-2
- Independent supply concept on V<sub>CC</sub> and V<sub>BAT</sub> pins
- Fail safe features
  - TxD-timeout
  - overtemperature shutdown
  - overtemperature warning
- Extended supply range on V<sub>cc</sub> and V<sub>IO</sub> supply
- CAN short circuit proof to ground, battery and V<sub>cc</sub>
- Overtemperature protection
- Advanced bus biasing according to ISO 11898-2 (2016)
- Bus Wake-up Pattern (WUP) function with optimized filter time (0.5 μs 1.8 μs) for worldwide OEM usage
- Wake-up pattern (WUP) detection in all low-power modes
- Wake-up frame (WUF) detection according to ISO 11898-2 (2016)
- Wake-up frame detection with CAN FD tolerant feature
- Local wake-up input
- SPI clock frequency up to 4 MHz
- Green Product (RoHS compliant)

# **Potential applications**

- Car powertrain and transmission applications
- HS CAN networks in automotive applications



#### Overview

• HS CAN networks in industrial applications

# **Product validation**

Qualified for automotive applications with higher temperature requirements as well as with extended lifetime requirements. Product validation according to AEC-Q100.

# Description

As an interface between the physical bus layer and the CAN protocol controller, the TLT9255W drives the signals to the bus and protects the microcontroller from interference generated within the network. Based on the high symmetry of the CANH and CANL signals, the TLT9255W provides a very low level of electromagnetic emission within a wide frequency range, allowing the operation of the TLT9255W without a common mode choke in automotive and industrial applications.

The TLT9255W is enclosed in an RoHS compliant PG-TSON-14 package and fulfills the requirements of the ISO11898-2 (2016).

The TLT9255W is part of the Infineon standard HS CAN transceiver family and provides beside CAN partial networking functions also a CAN FD capability up to 5 MBit/s in HS CAN networks. Configured as a partial networking HS CAN transceiver the TLT9255W can drive and receive CAN FD messages. it can also be used to block the payload of CAN FD messages. This CAN FD tolerant feature allows the usage of microcontrollers in CAN FD networks, which are not CAN FD capable.

The SPI of TLT9255W controls the setup of the wake-up messages and the status message generated by the internal state machine. Most of the functions, including wake-up functions, INH output control, mode control, undervoltage control are configurable by the SPI. This allows a very flexible usage of the TLT9255W in different applications.

The two non-low power modes (Normal-operating Mode and Receive-only Mode) and the two low power modes (Sleep Mode and Stand-by Mode) provide minimum current consumption based on the required functionality.

In Sleep Mode the TLT9255W can detect a wake-up pattern (WUP) on the HS CAN and then change the mode of operation accordingly; even at a quiescent current below 26 μA over the full temperature range.

In Selective-wake Sub-mode the TLT9255W monitors the CAN messages on the HS CAN bus. If the TLT9255W detects a matching wake-up frame, then it triggers a mode change. The TLT9255W monitors wake-up identifiers up to 29 bit as well as up to 64 bit wide data. The internal protocol handler counts all bus errors. The SPI indicates failures, error counter overflow and synchronization failures to the microcontroller.

The unique power-supply management allows the application to use the TLT9255W without the battery supply  $V_{BAT}$  connected. In this case the TLT9255W is supplied over the  $V_{CC}$  pin. The  $V_{IO}$  voltage reference supports 3.3 V and 5 V supplied microcontrollers.

Based on Infineon Smart Power Technology (SPT), the TLT9255W provides excellent immunity together with a very high electromagnetic immunity (EMI). The TLT9255W and the Infineon SPT are AEC qualified and tailored to withstand the harsh conditions of the automotive environment.

Туре	Package	Marking
TLT9255WLC	PG-TSON-14	T9255W



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Block Diagram

# 2 Block Diagram



Figure 1 Block Diagram



Pin Configuration

# 3 Pin Configuration

# 3.1 Pin Assignment



Figure 2 Pin configuration for PG-TSON-14

# 3.2 Pin Definitions

#### Table 1Pin definitions and functions

Pin	Symbol	Function
1	TxD	Transmit Data Input;
		integrated pull-up current source to $V_{10}$ ,
		"low" to drive a dominant signal on CANH and CANL
2	GND	Ground.
3	V <sub>cc</sub>	Transmitter Supply Voltage;
		100 nF decoupling capacitor to GND is recommended
4	RxD	Receive Data Output;
		"low" while a dominant signal is on the HS CAN bus,
		output voltage adapted to the voltage on the V <sub>10</sub> level shift input
5	V <sub>IO</sub>	Level Shift Input;
		reference voltage for the digital input and output pins,
		100 nF decoupling capacitor to GND is recommended
6	MISO	SPI Serial Data Output;
		tri-state while CSN is "high"
7	INH	Inhibit Output;
		open drain output to control external circuitry



## **Pin Configuration**

Pin	Symbol	Function
8	SCLK	SPI Clock Input;
		integrated pull-down current source to GND
9	WAKE	Wake-up Input;
		local wake-up input, terminated against GND and V <sub>BAT</sub> ,
		wake-up input sensitive to signal changes in both directions
10	V <sub>BAT</sub>	Battery Supply Voltage;
		100 nF decoupling capacitor to GND is recommended
11	MOSI	SPI Serial Data Input;
		integrated pull-down current source to GND
12	CANL	Low-level HS CAN Bus Line
13	CANH	High-level HS CAN Bus Line
14	CSN	SPI Chip Select Not Input;
		integrated pull-up current source to $V_{10}$
PAD	-	Connect to PCB heat sink area.
		Do not connect to other potential than GND.

#### Table 1Pin definitions and functions (cont'd)



**General Product Characteristics** 

# 4 General Product Characteristics

# 4.1 Absolute Maximum Ratings

#### Table 2 Absolute Maximum Ratings<sup>1)</sup>

All voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Voltages	- <u>+</u>			1		•	<u>+</u>
Battery supply voltage	V <sub>BAT</sub>	-0.3	-	40	V	-	P_9.1.1
Transmitter supply voltage	V <sub>cc</sub>	-0.3	-	6.0	V	-	P_9.1.2
Digital voltage reference	V <sub>IO</sub>	-0.3	-	6.0	V	-	P_9.1.3
CANH DC voltage versus GND	V <sub>CANH</sub>	-40	-	40	V	-	P_9.1.4
CANL DC voltage versus GND	V <sub>CANL</sub>	-40	_	40	V	-	P_9.1.5
Differential voltage between CANH and CANL	V <sub>CAN_DIFF</sub>	-40	-	40	V	-	P_9.1.6
Voltage at pin WAKE	V <sub>WAKE</sub>	-27	_	40	V	-	P_9.1.7
Voltage at pin INH	V <sub>INH</sub>	-0.3	-	V <sub>BAT</sub> +0 .3	V	_	P_9.1.8
Voltage at pin digital input pins: CSN, SCLK, MOSI, TxD	V <sub>Max_In</sub>	-0.3	-	V <sub>IO</sub> + 0.3	V	-	P_9.1.9
Voltage at pin digital output pins: MISO, RxD	V <sub>Max_Out</sub>	-0.3	-	V <sub>IO</sub> + 0.3	V	-	P_9.1.10
Currents						+	-
Maximum output current on INH	I <sub>INH_Max</sub>	-1.0	-	-	mA	-	P_9.1.11
Maximum output current on digital output pins: MISO, RxD	I <sub>Out_Max</sub>	-20	-	20	mA	-	P_9.1.12
Temperatures	1	ŀ		W	-	-	-
Junction Temperature	T <sub>j</sub>	-40	-	160	°C	-	P_9.1.13
Storage Temperature	T <sub>stg</sub>	-55	_	150	°C	-	P_9.1.14



#### **General Product Characteristics**

#### Table 2Absolute Maximum Ratings<sup>1)</sup> (cont'd)

All voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	ymbol Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
ESD Resistivity			1	1			-
ESD immunity at CANH, CANL, WAKE and V <sub>BAT</sub> versus to GND	V <sub>ESD_HBM_CAN</sub>	-10	-	10	kV	HBM <sup>2)</sup>	P_9.1.15
ESD immunity at all other pins	V <sub>ESD_HBM</sub>	-4	-	4	kV	HBM <sup>2)</sup>	P_9.1.16
ESD immunity at corner pins	V <sub>ESD_CDM_CP</sub>	-750	-	750	V	CDM <sup>3)</sup>	P_9.1.17
ESD immunity at any pin	V <sub>ESD_CDM_OP</sub>	-500	-	500	V	CDM <sup>3)</sup>	P_9.1.18

1) Not subject to production test, specified by design.

2) ESD susceptibility, Human Body Model "HBM" according to ANSI/ESDA/JEDEC JS001 (1.5k Ω, 100 pF.)

3) ESD susceptibility, Charged Device Model "CDM" according to EIA/JESD22-C101 or ESDA STM 5.3.1.

#### Notes

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



**General Product Characteristics** 

## 4.2 Functional Range

#### Table 3Functional range

Parameter	Symbol		Value	S	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Supply Voltages					·		
Transceiver battery supply voltage	V <sub>BAT</sub>	5.5	-	40	V	-	P_9.2.1
Transmitter supply voltage	V <sub>cc</sub>	4.75	-	5.25	V	-	P_9.2.2
Digital voltage reference	V <sub>IO</sub>	3.0	-	5.5	V	-	P_9.2.3
Thermal Parameters	¥	•			<u>.</u>	+	
Junction Temperature	T <sub>j</sub>	-40	-	150	°C	-	P_9.2.4

*Note:* Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.



#### **General Product Characteristics**

#### 4.3 Thermal Resistance

*Note:* This thermal data was generated in accordance with JEDEC JESD51 standards. For more information please visit **www.jedec.org**.

#### Table 4Thermal resistance1)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Thermal Resistance			•	•			
Junction to ambient	R <sub>thJA_TSON14</sub>	-	51	-	K/W	2)	P_9.3.5
Thermal Shutdown Jun					-	-	
Thermal shut-down temperature	T <sub>JSD</sub>	170	180	190	°C	-	P_9.3.3
Thermal shutdown hysteresis	ΔΤ	5	10	20	К	-	P_9.3.4

1) Not subject to production test, specified by design.

 Specified R<sub>thJA</sub> value is according to Jedec JESD51-2,-7 at natural convection on FR4 2s2p board; The Product (Chip + Package) was simulated on a 76.2 × 114.3 × 1.5 mm board with 2 inner copper layers (2 × 70 mm Cu, 2 × 35 mm Cu).



**High Speed CAN Functional Description** 

# 5 High Speed CAN Functional Description

High speed CAN (HS CAN) is a serial bus system that connects microcontrollers, sensors and actuators for realtime control applications. ISO 11898-2 (2016) describes the use of the Controller Area Network (CAN) within road vehicles. According to the 7-layer OSI reference model the physical layer of a HS CAN bus system specifies the data transmission from one CAN node to all other available CAN nodes within the network. The CAN transceiver is part of the physical layer. The physical layer specification of a CAN bus system includes all electrical specifications of a CAN network.

The TLT9255W supports:

- standard bus wake-up functionality
- CAN Partial Networking with selective wake-up functionality according to ISO 11898-2 (2016)
- CAN Flexible data rate (CAN FD) transmission up to 5 MBit/s



# 5.1 High Speed CAN Physical Layer

Figure 3 High speed CAN bus signals and logic signals



#### High Speed CAN Functional Description

The TLT9255W is a HS CAN transceiver operating as an interface between the CAN controller and the physical bus medium. A HS CAN network is a two wire, differential network which allows data transmission rates up to 5 MBit/s. HS CAN networks have two signal states on the CAN bus (see **Figure 3**):

- dominant
- recessive

The CANH and CANL pins are the interface to the CAN bus and operate both as an input and as an output. The RxD and TxD pins are the interface to the microcontroller. The TxD pin is the serial data input from the CAN controller. The RxD pin is the serial data output to the CAN controller. The HS CAN transceiver TLT9255W includes a receiver and a transmitter unit, allowing the transceiver to send data to the bus medium and monitoring the data from the bus medium at the same time (see **Figure 1**). The TLT9255W converts the serial data stream, which is available on the transmit data input TxD, to a differential output signal on the CAN bus, provided by the CANH and CANL pins. The receiver stage of the TLT9255W monitors the data on the CAN bus and converts it to a serial, single-ended signal on the RxD output pin. A "low" signal on the TxD pin creates a dominant signal on the CAN bus, followed by a "low" signal on the RxD pin (see **Figure 3**). The feature of broadcasting data to the CAN bus and listening to the data traffic on the CAN bus simultaneously is essential to support the bit-to-bit arbitration within CAN networks.

ISO 11898-2 (2016) defines the voltage levels for HS CAN transceivers. Whether a data bit is dominant or recessive depends on the voltage difference between the CANH and CANL pins:

#### $V_{\rm Diff} = V_{\rm CANH} - V_{\rm CANL}$

To transmit a dominant signal to the CAN bus the amplitude of the differential signal  $V_{\text{Diff}}$  is  $\ge 1.5$  V. To receive a recessive signal from the CAN bus the amplitude of the differential  $V_{\text{Diff}}$  is  $\le 0.5$  V.

Partially supplied High-Speed CAN networks have CAN bus nodes with different power supply conditions. Some nodes are connected to the common power supply, while other nodes are disconnected from the power supply and in power-down state. Regardless of whether the CAN bus subscriber is supplied or not, each subscriber connected to the common bus media must not interfere with the communication. The TLT9255W is designed to support Partially supplied networks. In power-down state, the receiver input resistors are switched off and the transceiver input has a high resistance.

For permanently supplied ECUs, the TLT9255W provides low power modes. In these low power modes, the current consumption of the TLT9255W is optimized to a minimum, while the TLT9255W can still recognize wake-up patterns or wake-up frames on the CAN bus and signal the wake-up event to the external microcontroller.

The voltage level on the digital input TxD and the digital output RxD is determined by the reference supply level at the  $V_{IO}$  pin. Depending on the voltage level at the  $V_{IO}$  pin, the signal levels on the logic pins (CSN, SCLK, MOSI, MISO, TxD and RxD) are compatible to microcontrollers having a 5 V or 3.3 V I/O supply. It is highly recommended that the digital power supply of  $V_{IO}$  of the transceiver is connected to the I/O power supply of the microcontroller; this is the way it is intended to be used (see **Figure 53**).



#### **Modes of Operation**

# 6 Modes of Operation

The TLT9255W supports four different Modes of operation (see **Figure 4**):

- Normal-operating Mode (Chapter 6.1)
- Receive-only Mode (Chapter 6.2)
- Stand-by Mode (Chapter 6.3)
- Sleep Mode (Chapter 6.4)



Figure 4 Mode of operation

Table 5	Types of Modes and Sub-Modes
---------	------------------------------

Type of mode	Mode	Sub-Mode
Normal power mode	Normal-operating mode	-
	Receive-only Mode	-



#### **Modes of Operation**

#### Table 5Types of Modes and Sub-Modes (cont'd)

Type of mode	Mode	Sub-Mode
Low power mode	Stand-by Mode	-
	Sleep Mode	Sleep WUP Sub-Mode
		Selective Wake Sub-Mode
		Selective Sleep Sub-Mode



#### Modes of Operation

#### 6.1 Normal-operating Mode

In Normal-operating mode all functions of the TLT9255W are available. The TLT9255W can receive data from the HS CAN bus as well as transmit data to the HS CAN bus.

- The transmitter is active and drives the serial data stream on the TxD input pin to the bus pins CANH, CANL.
- The normal mode receiver is active and converts the signals from the bus to a serial data stream on the RxD output pin.
- The bus biasing is on.
- The TxD timeout function is enabled (Chapter 7.4).
- The overtemperature protection is enabled (Chapter 7.5).
- The undervoltage detection on V<sub>BAT</sub> is enabled(Chapter 7.2.1)
- The undervoltage detection on V<sub>cc</sub> is enabled (**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  is enabled (Chapter 7.2.4).
- The INH output pin is "high".
- A valid wake-up pattern is not signalled in the SPI bit **WUP** (Chapter 6.7.1).
- Only if the selective wake function is enabled (SWK\_EN = 1), then the HS CAN bus will be continuously monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is disabled (Chapter 6.7.3).

Conditions for entering the Normal-operating Mode:

• Normal-operating Mode can be entered via an SPI MC command from any mode of operation.

Conditions for leaving the Normal-operating Mode:

- If V<sub>IO</sub> < V<sub>IO\_UV</sub> AND t<sub>VIO\_UV\_T</sub> has expired ANDt<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode
- If V<sub>CC</sub> < V<sub>CC\_UV</sub> AND t<sub>VCC\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode.
- An SPI MC command triggers a mode change.

Figure 5 shows possible mode changes.



Figure 5 Mode changes in Normal-operating Mode



#### **Modes of Operation**

#### 6.2 Receive-only Mode

In Receive-only Mode the transmitter is disabled and the receiver is enabled. The TLT9255W can receive data from the HS CAN bus, but cannot transmit data to the HS CAN bus.

- The transmitter is disabled and the data available on the TxD input is blocked.
- The RxD output pin indicates the data received by the normal-mode receiver.
- The bus biasing is on.
- The TxD timeout function is disabled (Chapter 7.4).
- The overtemperature protection is disabled (Chapter 7.5).
- The undervoltage detection on  $V_{BAT}$  is enabled (Chapter 7.2.1)
- The undervoltage detection on V<sub>cc</sub> is enabled (**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  is enabled (**Chapter 7.2.4**).
- The INH output pin is "high".
- A valid wake-up pattern is not signalled in the SPI bit **WUP** (Chapter 6.7.1).
- Only if the selective wake function is enabled (SWK\_EN = 1), then the HS CAN bus is continuously monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is disabled (Chapter 6.7.3).

Conditions for entering the Receive-only Mode:

• Receive-only Mode can be entered via an SPI MC command from any mode of operation.

Conditions for leaving the Received-only Mode:

- If V<sub>IO</sub> < V<sub>IO\_UV</sub> AND t<sub>VIO\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode.
- If V<sub>CC</sub> < V<sub>CC\_UV</sub> AND t<sub>VCC\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode.
- An SPI MC command triggers a mode change.

**Figure 6** shows possible mode changes.



Figure 6 Mode changes in Receive-only Mode



#### **Modes of Operation**

#### 6.3 Stand-by Mode

Stand-by Mode is a low power mode of the TLT9255W with both the transmitter and the receiver disabled. In Stand-by Mode the transceiver can neither send data to the HS CAN bus nor can it receive data from the HS CAN bus:

- The transmitter is disabled and the data available on the TxD input is blocked.
- The RxD output pin indicates a wake-up event (**Chapter 6.8**). If no wake-up event is pending, then the default value of the RxD output pin is "high".
- After Power on Reset the bus biasing is off. Chapter 6.6 describes the conditions for the bus biasing.
- The TxD timeout function is disabled (Chapter 7.4).
- The overtemperature protection is disabled (Chapter 7.5).
- The undervoltage detection on  $V_{BAT}$  is enabled (Chapter 7.2.1)
- The undervoltage detection on V<sub>cc</sub> is enabled (**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  is enabled (**Chapter 7.2.4**).
- The INH output pin is "high".
- If the selective wake function is disabled (SWK\_EN = 0), then the HS CAN bus is continuously monitored for a valid wake-up pattern (Chapter 6.7.1). If the selective wake function is enabled, then a valid wake-up pattern is not signalled in the SPI bit WUP.
- Only if the selective wake function is enabled (SWK\_EN = 1), then the HS CAN bus is continuously monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is enabled (**Chapter 6.7.3**).
- If  $V_{10} > V_{10}$  uv, then a mode change is possible.



#### Modes of Operation

Conditions for entering the Stand-by Mode:

- After Power on Reset: If V<sub>CC</sub> OR V<sub>BAT</sub> is within the functional range for at least t<sub>PON</sub>, then the TLT9255W enters Stand-by Mode.
- If a wake-up (WUP, WUF, LWU) is detected in Sleep Mode, then the TLT9255W enters Stand-by Mode.
- If the selective wake unit is active (Selective wake Sub-Mode) AND if the value of the error counter is 32 (see Chapter 8.3),

then the TLT9255W enters Stand-by Mode.

• Stand-by Mode can be entered via an SPI MC command from any mode of operation.

Conditions for leaving the Stand-by Mode:

- If V<sub>IO</sub> < V<sub>IO\_UV</sub> AND t<sub>VIO\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode.
- If V<sub>CC</sub> < V<sub>CC\_UV</sub> AND t<sub>VCC\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then this triggers a mode change to Sleep Mode.
- An SPI MC command triggers a mode change.

Figure 7 shows possible mode changes.



Figure 7 Mode changes in Stand-by Mode



#### **Modes of Operation**

#### 6.4 Sleep Mode

Sleep mode is a low power mode with minimized quiescent current. If the TLT9255W detects a wake-up event in Sleep Mode, then it changes to Stand-by Mode. Sleep Mode has three Sub-Modes.







Figure 9 Sub-Modes in Sleep Mode



#### Modes of Operation

**Figure 10** shows the internal behavior of the TLT9255W in case the microcontroller sends a change to Sleep Mode SPI command.



Figure 10 Internal behavior of the TLT9255W after receiving a change to Sleep Mode SPI command



#### Modes of Operation

#### 6.4.1 Sleep WUP Sub-Mode

Sleep WUP Sub-Mode is a low power mode of the TLT9255W. Sleep WUP Sub-Mode reduces current consumption. The following conditions are valid for the Sleep WUP Sub-Mode:

- The transmitter is disabled and the data available on the TxD input is blocked.
- The value of the RxD output pin depends on the power supply circuit of  $V_{10}$ .
  - Permanent power supply of V<sub>IO</sub> (INH pin is not used)
     The RxD output pin is "high"
  - The INH pin controls the power supply of V<sub>IO</sub>
     The RxD output pin is "low"
- If the *t*<sub>silence</sub> timer has expired, then the bus biasing is off.
- The TxD timeout function is disabled (Chapter 7.4).
- The overtemperature protection is disabled (Chapter 7.5).
- The undervoltage detection on  $V_{BAT}$  (Chapter 7.2.1) is not signalled in the SPI bit VBAT\_UV.
- The undervoltage detection on V<sub>cc</sub> is disabled(**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  (**Chapter 7.2.4**) is not signalled in the SPI bits **VIO\_LTUV** and **VIO\_STUV**.
- The INH output pin is "low". The SPI bit **VBAT\_CON** in the register **SWK\_CTRL\_1** controls the behavior of the INH pin.
- The HS CAN bus is continuously monitored for a valid wake-up pattern (Chapter 6.7.1).
- The HS CAN bus is not monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is enabled.

Conditions for entering the Sleep WUP Sub-Mode:

- If V<sub>IO</sub> < V<sub>IO\_UV</sub> (V<sub>IO</sub> undervoltage) AND t<sub>VIO\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then the TLT9255W enters Sleep WUP Sub-Mode.
- If V<sub>CC</sub> < V<sub>CC\_UV</sub> (V<sub>CC</sub> undervoltage) AND t<sub>VCC\_UV\_T</sub> has expired AND t<sub>silence</sub> has expired, then the TLT9255W enters Sleep WUP Sub-Mode. The SPI bit STTS\_EN controls this state transition.
- The Sleep WUP Sub-Mode can be entered via an SPI MC command from any mode of operation.

Conditions for leaving the Sleep WUP Sub-Mode:

- If a wake-up (WUP, LWU) is detected in Sleep WUP Sub-Mode, then the TLT9255W enters Stand-by Mode.
- An SPI MC command triggers a mode change to any mode of operation.



Figure 11 Mode change in Sleep WUP Sub-Mode



#### Modes of Operation

#### 6.4.2 Selective Wake Sub-Mode

Selective Wake Sub-Mode is a low power mode of the TLT9255W. Only if the selective wake function is enabled (**SWK\_EN=** 1), then the TLT9255W can enter Selective Wake Sub-Mode. **Chapter 8** describes the partial networking functionality and the configuration. The following conditions are valid for the Selective Wake Sub-Mode:

- The transmitter is disabled and the data available on the TxD input is blocked.
- The default value of the RxD output pin depends on the power supply circuit of  $V_{10}$ .
  - Permanent power supply of V<sub>IO</sub> (INH pin is not used) The RxD output pin is "high"
  - The INH pin controls the power supply of V<sub>IO</sub>
     The RxD output pin is "low"
- The bus biasing is on.
- The TxD timeout function is disabled (Chapter 7.4).
- The overtemperature protection is disabled (Chapter 7.5).
- The undervoltage detection on V<sub>BAT</sub> is enabled (Chapter 7.2.1).
- The undervoltage detection on  $V_{cc}$  is disabled(**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  is enabled (**Chapter 7.2.4**).
- The INH output pin is "low". The SPI bit VBAT\_CON in the register SWK\_CTRL\_1 controls the behavior of the INH pin.
- A valid wake-up pattern is not signalled in the SPI bit WUP (Chapter 6.7.1).
- The HS CAN bus is continuously monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is enabled.



#### Modes of Operation

Conditions for entering the Selective Wake Sub-Mode:

• The Selective Wake Sub-Mode can be entered via an SPI MC command from any mode of operation.

• If the TLT9255W detects a WUP in Selective Sleep Sub-Mode, then it enters Selective Wake Sub-Mode. Conditions for leaving the Selective Wake Sub-Mode:

- If a wake-up (WUF, LWU) is detected in Selective Wake Sub-Mode, then Stand-by Mode is entered.
- If the error counter > 31 (Chapter 8.3) in Selective Wake Sub-Mode, then Stand-by Mode is entered.
- If *t*<sub>silence</sub> has expired, then Selective Sleep Sub-Mode is entered.
- An SPI MC command will trigger a mode change to any mode of operation.



Figure 12 Mode change in Selective Wake Sub-Mode



#### Modes of Operation

#### 6.4.3 Selective Sleep Sub-Mode

Selective Sleep Sub-mode is a low power mode with optimized quiescent current. The following conditions are valid for the Selective Wake Sub-Mode:

- The transmitter is disabled and the data available on the TxD input is blocked.
- The default value of the RxD output pin depends on the power supply circuit of  $V_{10}$ .
  - Permanent power supply of V<sub>IO</sub> (INH pin is not used)
     The RxD output pin is "high"
  - The INH pin controls the power supply of V<sub>IO</sub> The RxD output pin is "low"
- The bus biasing is off.
- The TxD timeout function is disabled (Chapter 7.4).
- The overtemperature protection is disabled (Chapter 7.5).
- The undervoltage detection on V<sub>BAT</sub> (Chapter 7.2.1) is not signalled in the SPI bit VBAT\_UV.
- The undervoltage detection on V<sub>cc</sub> is disabled(**Chapter 7.2.2**).
- The undervoltage detection on  $V_{10}$  (Chapter 7.2.4) is not signalled in the SPI bits VIO\_LTUV and VIO\_STUV.
- The INH output pin is "low". The SPI bit VBAT\_CON in the register SWK\_CTRL\_1 controls the behavior of the INH pin.
- The HS CAN bus is continuously monitored for a valid wake-up pattern (**Chapter 6.7.1**), but a valid wakeup pattern is not signalled in the SPI bit **WUP** (**Chapter 6.7.1**).
- The HS CAN bus is not monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is enabled.

Conditions for entering the Selective Sleep Sub-Mode:

• If there is no communication on the HS CAN bus for longer than  $t_{\text{Silence}}$  in the Selective Wake Sub-Mode, then the TLT9255W enters the Selective Sleep Sub-Mode.

Conditions for leaving the Selective Sleep Sub-Mode:

- If a WUP is detected, then Selective Wake Sub-Mode is entered.
- If an LWU has been detected, then Stand-by Mode will be entered.
- An SPI MC command triggers a mode change to any mode of operation.



Figure 13 Mode change in Selective Sleep Sub-Mode



#### **Modes of Operation**

#### 6.5 Power On Reset

Power on Reset is a transition state of the TLT9255W after power is applied and the transceiver is not yet fully functional.

- The transmitter and receiver are disabled.
- The bus biasing is off.
- The TxD timeout function is disabled.
- The overtemperature protection is disabled.
- The undervoltage detection on V<sub>BAT</sub> is enabled (Chapter 7.2.1), but it is not signalled in the SPI bit VBAT\_UV.
- The undervoltage detection on  $V_{\rm CC}$  is disabled.
- The undervoltage detection on V<sub>IO</sub> is enabled (Chapter 7.2.4), but it is not signalled in the SPI bits VIO\_LTUV and VIO\_STUV.
- The SPI communication is blocked (MOSI, SCLK, CSN),
- RxD and MISO pins are high impedance.
- TxD pin is blocked
- If  $V_{BAT} > V_{BAT POD}$  OR  $V_{CC} > V_{CC POD}$ , then the INH output pin is switched on
- All SPI registers are reset to default values.
- The HS CAN bus is not continuously monitored for a valid wake-up pattern (Chapter 6.7.1)
- The HS CAN bus is not monitored for a valid WUF (Chapter 6.7.2).
- Local wake-up function is disabled.
- Conditions for entering the Power on Reset:
- $V_{BAT} < V_{BAT POD} AND V_{CC} < V_{CC POD}$  threshold.
- Conditions for leaving the Power on Reset:
- If  $V_{BAT}$  is within the functional range for at least  $t_{PON}$  OR if  $V_{CC}$  is within the functional range for at least  $t_{PON}$ , then the TLT9255W enters Stand-by Mode

Figure 14 shows power up behavior and power down behavior:



Figure 14 Power down and power up behavior

#### SPI bit POR

The **POR** flag indicates that all registers are reset and the state machine is in the default mode (Stand-by Mode) If all of the following conditions are fulfilled, then the **POR** flag is set:

- $V_{BAT}$  is within the functional range for at least  $t_{PON}$  OR  $V_{CC}$  is within the functional range for at least  $t_{PON}$ , then the TLT9255W enters Stand-by Mode
- V<sub>10</sub> is within the functional range (SPI communication is possible)



#### Modes of Operation

Any of the following events resets the **POR** flag:

- an SPI clear command
- a transition to the Normal-operating Mode

# 6.6 Automatic Bus Voltage Biasing

The automatic bus voltage biasing improves EMC performance of the entire network and increases the reliability of communication performance in networks using CAN partial networking.

The automatic bus voltage biasing is enabled in all low power modes. The biasing unit operates independently from all other transceiver functions and only depending on the network activity ( $t_{\text{Silence}}$ ). If  $t_{\text{Silence}}$  has expired, then there is no activity on the CAN bus. The  $t_{\text{Silence}}$  timer is restarted under the following conditions:

- If t<sub>silence</sub> has expired in Sleep WUP Sub-Mode AND a WUP is detected
- If t<sub>Silence</sub> has not expired in Sleep WUP Sub-Mode AND a rising or falling edge is detected AND the pulse width (dominant or recessive) is greater than t<sub>Filter</sub>
- If a WUP is detected in Selective Sleep Sub-Mode
- If t<sub>silence</sub> has expired in Stand-by Mode AND a WUP is detected
- If the t<sub>Silence</sub> has not expired in Stand-by Mode AND a rising edge or a falling edge is detected AND the pulse width (dominant or recessive) is greater than t<sub>Filter</sub>
- If a rising or falling edge is detected in any other mode AND the pulse width (dominant or recessive) is
  greater than t<sub>Filter</sub>

If there is no activity on the bus for longer than  $t_{SILENCE}$ , then the internal resistors bias the bus pins towards GND. On detection of a valid wake-up pattern (WUP), the internal biasing is enabled and terminates the biasing resistors towards 2.5 V within  $t > t_{RW_{Bias}}$ .



Figure 15 Bus Biasing and t<sub>Silence</sub>



#### **Modes of Operation**

#### 6.7 Wake-up event

Valid wake-up events are:

- a Wake-up pattern (WUP) in Sleep WUP Sub-Mode
- a Wake-up frame (WUF) in Selective Wake Sub-Mode
- a Local Wake-up (LWU) in Sleep WUP Sub-Mode, Selective Sleep Sub-Mode or Selective Wake Sub-Mode

If a valid wake-up event is detected, then this triggers a mode change to Stand-by Mode.

## 6.7.1 Wake-up pattern (WUP)

Within the maximum wake-up time  $t_{WAKE}$ , the wake-up pattern consists of the following sequence (see **Figure 16**):

- a dominant signal with pulse width t > t<sub>Filter</sub>
- a recessive signal with pulse width *t* > *t*<sub>Filter</sub>
- a dominant signal with pulse width t > t<sub>Filter</sub>



Figure 16 Wake-up pattern



Figure 17 WUP detection



#### Modes of Operation

The **WUP** bit in the register **WAKE\_STAT** indicates detection of a wake-up pattern on the HS CAN bus. If the transceiver is not in the Selective Sleep Sub-Mode AND if the transceiver detects a valid wake-up pattern, then the WUP bit is set. An SPI clear command resets the bit. A wake-up is not executed under the following conditions:

- A mode change to Normal-operating Mode is performed during the wake-up pattern.
- The maximum wake-up time t<sub>WAKE</sub> expires before a valid WUP is detected.
- The transceiver is powered down ( $V_{CC} < V_{CC_{POD}}$  AND  $V_{BAT} < V_{BAT_{POD}}$ ).

#### 6.7.2 Wake-up frame (WUF)

If the selective wake unit is enabled (**SWK\_EN** =1), then the selective wake unit continuously monitors the HS CAN Bus for a valid wake-up frame. If a valid WUF is detected, then the **WUF** bit in the register **WAKE\_STAT** is set to "1". An SPI clear command resets the **WUF** bit. **Chapter 8** describes the selective wake feature.



#### Modes of Operation

## 6.7.3 Local Wake-up (LWU)

The WAKE input pin can detect a rising edge as well as a falling edge as a wake-up event (configurable in LWU\_NEG, LWU\_POS). The LWU bit in the register WAKE\_STAT indicates that a local wake-up is detected on the local wake-up pin. The transceiver sets the LWU bit. An SPI command resets the LWU bit. The LWU\_DIR bit in the register WAKE\_STAT indicates on which edge a local wake-up has been detected. The transceiver sets the LWU\_DIR flag and it is only valid, if a local wake-up has been detected. Chapter 10.6.3 describes the local wake-up timing.



Figure 18 Local wake-up negative edge



Figure 19 Local wake-up positive edge



#### Modes of Operation

#### 6.8 RxD pin wake-up behavior

The RxD output pin indicates a wake-up event to the microcontroller. On detection of a valid wake-up event the RxD output pin reacts with one of the following behaviors, depending on the **WAKE\_TOG** bit in the SPI register **HW\_CTRL**:

- RxD output pin is set to "low"
- RxD output pin starts to toggle

If Stand-by Mode is re-entered by a mode change (microcontroller) the previous indication of a valid wake-up event is not signalled on the RxD pin. Only if a new wake-up event has been detected, the RxD pin indicates the wake-up event. The clearing of a **WUP**, **WUF** or **LWU** has no influence on the behavior of the RxD pin.

## 6.8.1 RxD permanent "low"

If a valid wake-up event is detected AND if SPI bit **WAKE\_TOG** = 0, then the RxD output pin is set to "low". If a mode change occurs, then the RxD output pin behavior is defined by the new state.



Figure 20 RxD "low" after wake-up event



Figure 21 RxD "low" after wake-up event (permanently supplied V<sub>10</sub>)



#### Modes of Operation

#### 6.8.2 RxD Toggle

If **WAKE\_TOG** is set to 1 AND if a valid wake-up event is detected AND if  $V_{10}$  is within the functional range, then the RxD output pin starts to toggle from "low" to "high" and "high" to "low" with time period of  $t_{Toggle}$ . **Figure 22** and **Figure 23** show this behavior. If a mode change occurs, then the RxD output pin behavior is defined by the new state.



Figure 22 RxD toggling behavior after wake-up event



Figure 23 RxD toggling behavior after wake-up event (permanently supplied  $V_{10}$ )



**Fail Safe Functions** 

# 7 Fail Safe Functions

## 7.1 Short Circuit Protection

The CANH and CANL bus pins are proven to cope with a short circuit fault to GND and to the supply voltages. A current limiting circuit protects the transceiver from damage.

#### 7.2 Undervoltage detection

The TLT9255W has independent undervoltage detection on  $V_{BAT}$ ,  $V_{CC}$  and  $V_{IO}$ . Undervoltage events at these pins may have impact on the functionality of the device and also may change the mode of operation.

## 7.2.1 Undervoltage detection on V<sub>BAT</sub>

If the power supply  $V_{BAT} < V_{BAT_{UV}}$  for more than the glitch filter time  $t_{VBAT_{filter}}$ , then an undervoltage is detected. On detection of undervoltage the TLT9255W performs the following actions:

- disable Local wake-up
- Set the bit VBAT\_UV in the SPI register TRANS\_UV\_STAT to "1". After the completion of a Power on Reset or after a transition from Sleep Mode to Stand-by Mode the V<sub>BAT</sub> supply stabilization period must be completed before an undervoltage notification can be recorded in the VBAT\_UV bit. The undervoltage notification is only possible once the V<sub>BAT</sub> supply has exceeded the threshold V<sub>BAT\_UV</sub>, that is V<sub>BAT</sub> > V<sub>BAT\_UV</sub>. Figure 25 shows this scenario.

Only an SPI command can reset the undervoltage bit **VBAT\_UV** (see **Chapter 9.2**). The glitch filter is implemented in order to prevent an undervoltage detection due to short voltage transients on  $V_{BAT}$ . Figure 24 shows the effect of glitch filter time in different undervoltage scenarios.



Figure 24 Undervoltage detection V<sub>BAT</sub>



#### **Fail Safe Functions**



Figure 25 Undervoltage detection V<sub>BAT</sub> during V<sub>BAT</sub> supply stabilization period

After power up the application can set the **VBAT\_CON** to "0" in the SPI Register **SUPPLY\_CTRL** in order to disable undervoltage detection.



#### Fail Safe Functions

# 7.2.2 Short-term Undervoltage detection on V<sub>cc</sub>

If the power supply  $V_{CC} < V_{CC_{UV}}$  for more than the glitch filter time  $t_{VCC_{filter}}$ , then a short-term undervoltage on  $V_{CC}$  is detected. The glitch filter prevents an undervoltage detection due to short voltage transients on  $V_{CC}$ . On detection of short-term undervoltage the TLT9255W performs the following actions:

- Set short-term undervoltage bit VCC\_STUV to "1" in the SPI register TRANS\_UV\_STAT. Only after the completion of a Power on Reset, the V<sub>CC</sub> supply stabilization period must be completed before an undervoltage notification can be recorded in the VCC\_STUV bit. After Power on Reset the undervoltage notification is only possible once the V<sub>CC</sub> supply has exceeded the threshold V<sub>CC\_UV</sub>, that is V<sub>CC</sub> > V<sub>CC\_UV</sub>. Figure 27 shows this scenario.
- disable the transmitter

An SPI command can reset the undervoltage bit **VCC\_STUV**. If  $V_{CC} > V_{CC_UV}$  for more than the glitch filter time  $t_{VCC_filter}$  AND if the transmitter recovery time  $t_{VCC_recovery}$  has expired, then the transmitter is re-enabled.



Figure 26 V<sub>cc</sub> undervoltage detection



Figure 27 Undervoltage detection V<sub>cc</sub> during V<sub>cc</sub> supply stabilization period after Power on Reset

# 7.2.3 Long-term undervoltage detection on V<sub>cc</sub>

If  $V_{CC} < V_{CC_{UV}}$  for more than the glitch filter time  $t_{VCC_{filter}}$ , then the undervoltage detection timer is started. If  $t_{VCC_{UV_{T}}}$  has expired, then a long-term undervoltage is detected and the bit **VCC\_LTUV** is set to "1". Besides, if the SPI bit **STTS\_EN** = 1 (default value) AND if  $t_{Silence}$  has expired, then a state transition to Sleep WUP Sub-


#### Fail Safe Functions

Mode is triggered. If  $V_{CC} > V_{CC_{UV}}$  for more than the glitch filter time  $t_{VCC_{filter}}$ , then the timer  $t_{VCC_{UV_{T}}}$  is stopped and reset. Only an SPI command can reset the undervoltage bit **VCC\_LTUV**. The  $t_{VCC_{UV_{T}}}$  can be configured in the SPI register **SUPPLY\_CTRL**.



Figure 28 V<sub>cc</sub> long-term undervoltage detection after power up



Figure 29 V<sub>cc</sub> long-term undervoltage detection during operation

## 7.2.4 Short-term Undervoltage detection on V<sub>IO</sub>

If the power supply  $V_{IO} < V_{IO_{UV}}$  for more than the glitch filter time  $t_{VIO_{filter}}$ , then short-term undervoltage on  $V_{IO}$  is detected. The glitch filter prevents an undervoltage detection due to short voltage transients on  $V_{IO}$ . On detection of short-term undervoltage the TLT9255W performs the following actions:

- Set the short-term undervoltage bit VIO\_STUV to "1" in the SPI register TRANS\_UV\_STAT. After the completion of a Power on Reset, the V<sub>IO</sub> supply stabilization period must be completed before an undervoltage notification can be recorded in the VIO\_STUV bit. After Power on Reset the undervoltage notification is only be possible once the V<sub>IO</sub> supply has exceeded the threshold V<sub>IO\_UV</sub>, that is V<sub>IO</sub> > V<sub>IO\_UV</sub>. Figure 31 shows this scenario.
- set the RxD pin to "low"
- disable SPI communication by switching the MISO pin to high impedance



#### Fail Safe Functions

• TLT9255W ignores all signals on the input TxD pin

Only an SPI command can reset the undervoltage bit **VIO\_STUV**. If  $V_{IO}$  has recovered ( $V_{IO} > V_{IO_UV}$ ) for more than the glitch filter time  $t_{VIO_filter}$  AND if the  $t_{VIO_recovery}$  time has expired, then the RxD pin returns to normal functionality depending on the mode of operation and the SPI communication is restored.



Figure 30 V<sub>10</sub> short-term undervoltage detection





## 7.2.5 Long-term Undervoltage detection on V<sub>IO</sub>

If  $V_{IO} < V_{IO_{UV}}$  for more than the glitch filter time  $t_{VIO_{filter}}$ , then the undervoltage detection timer is started. If  $t_{VIO_{UV_{T}}}$  expires, then a long-term undervoltage is detected. On detection of long-term undervoltage the TLT9255W performs the following actions:

- set the bit VIO\_LTUV to "1"
- perform a mode change to Sleep WUP Sub-Mode only after *t*<sub>silence</sub> has expired (no bus communication)



#### Fail Safe Functions

If  $V_{IO} > V_{IO_{UV}}$  for more than the glitch filter time  $t_{VIO_{III}}$ , then the timer  $t_{VIO_{UV_{T}}}$  is stopped and reset. Only an SPI command can reset the undervoltage bit **VIO\_LTUV**. The  $t_{VIO_{UV_{T}}}$  is configurable in the SPI Register **SUPPLY\_CTRL**.



Figure 32 V<sub>10</sub> long-term undervoltage detection after power up



Figure 33 V<sub>IO</sub> long-term undervoltage detection during operation

## 7.3 Unconnected Logic Pins

If the input pins are not connected and floating, the integrated pull-up and pull-down resistors at the digital input pins force the TLT9255W into fail safe behavior (see **Table 6**).

Table 6	Logical Inputs when unconnected
---------	---------------------------------

Input Signal	Default State	Comment
TxD	"high"	pull-up current source to V <sub>IO</sub>
MOSI	"low"	pull-down current source to GND



#### **Fail Safe Functions**

Table 6	Logical Inputs when unconnected (cont'd)
---------	--

Input Signal	Default State	Comment
SCLK	"low"	pull-down current source to GND
CSN	"high"	pull-up current source to V <sub>IO</sub>

## 7.4 TxD Time-out Function

If the logical signal on the TxD pin is permanently "low", then the TxD time-out feature protects the CAN bus from blocked communication due to this errant logic signal on TxD. A permanent "low" signal on the TxD pin can occur due to a locked-up microcontroller or in a short circuit on the printed circuit board, for example. In Normal-operating Mode, a "low" signal on the TxD pin for the time t >  $t_{TXD_{TO}}$  enables the TxD time-out feature and the TLT9255W disables the transmitter (see **Figure 34**) and sets the **TXD\_TO** bit in the register **TRANS\_STAT**. The timer  $t_{TXD_{TO}}$  is configurable in SPI register **TXD\_TO\_CTRL**. The receiver is still active and the RxD output pin continues monitoring data on the bus.



Figure 34 TxD time-out function

**Figure 34** shows how the transmitter is deactivated and re-activated.To release the transmitter after a TxD time-out event, the TLT9255W requires a signal change on the TxD input pin from "low" to "high".



#### **Fail Safe Functions**

## 7.5 Overtemperature Protection

Integrated overtemperature detection protects the TLT9255W from thermal overstress of the transmitter. The overtemperature protection is active in Normal-operating Mode only. The temperature sensor provides the temperature threshold  $T_{JSD}$ . If the junction temperature exceeds the upper threshold  $T_{JSD}$ , then the TLT9255W disables the transmitter and sets the bit **TSD**, indicating that a critical temperature situation is reached. After the device cools down the transmitter is re-enabled. Only an SPI command can reset the **TSD** bit. A hysteresis is implemented within the temperature sensor.



Figure 35 Overtemperature protection

## 7.6 Delay Time for Mode Change

The TLT9255W performs mode changes within the time window  $t_{Mode\_Change}$ . During mode changes  $(t_{Mode\_Change})$  the RxD output pin is permanently set to "high" and does not reflect the status on the CANH and CANL input pins. After the mode change is completed, the TLT9255W releases the RxD output pin.



#### CAN Partial Networking

## 8 CAN Partial Networking

Partial networking allows to exclude nodes from the CAN communication in a CAN network. If the TLT9255W is in the Selective Wake Sub-Mode, then a CAN frame can wake-up the TLT9255W. This feature is called selective wake and the CAN frame is called wake-up frame (WUF). The selective wake unit implements the selective wake feature.

### 8.1 Wake-up frame evaluation

For a WUF detection the TLT9255W evaluates, whether a received CAN frame is a valid wake-up frame. This wake-up frame evaluation consists of the following parts:

- CAN ID evaluation
- Frame data length code (DLC) and data field evaluation

If both parts are evaluated successfully AND if the CRC of the CAN Frame is valid, then a valid wake-up frame is detected (see **Figure 36**). The following chapter describes the process in more detail.



#### Figure 36 WUF detection

## 8.1.1 Wake-up frame identifier evaluation

If all relevant CAN ID bits of a CAN frame match the configured CAN ID bits in the TLT9255W, then a valid WUF CAN ID is received. The CAN ID mask excludes CAN ID bits from the evaluation. The CAN ID bits of a received CAN frame are compared bit by bit with the CAN ID configured in register **SWK\_ID0\_CTRL** to **SWK\_ID3\_CTRL**. If the received CAN ID is equal to the configured CAN ID, then the wake-up frame identifier evaluation is successful. The CAN ID mask (registers **SWK\_MASK\_ID0\_CTRL** to **SWK\_MASK\_ID3\_CTRL**) defines which bits the comparison considers. **Figure 37** shows an example of the CAN ID evaluation (11 bit CAN ID). The green background color defines the CAN ID bits which are not considered in the comparison.

Configured CAN ID	1 0 0 1 0 1 1 1 0 1 0
CAN ID mask	1 1 1 1 1 1 1 1 1 1 0
1 <sup>st</sup> valid WUF CAN ID 2 <sup>nd</sup> valid WUF CAN ID	1     0     0     1     0     1     1     0     1     0       1     0     0     1     0     1     1     1     0     1     1
Example of an invalid WUF CAN ID	1 0 0 1 0 1 1 0 1 1

Figure 37 CAN ID and CAN ID mask



#### **CAN Partial Networking**

The registers SWK\_ID0\_CTRL, SWK\_ID1\_CTRL, SWK\_ID2\_CTRL and SWK\_ID3\_CTRL configure the CAN ID. The IDE bit defines the CAN ID format (11 bit or 29 bit identifier). The registers SWK\_MASK\_ID0\_CTRL, SWK\_MASK\_ID1\_CTRL, SWK\_MASK\_ID2\_CTRL and SWK\_MASK\_ID3\_CTRL configure the CAN-ID mask.

### 8.1.2 DLC and data field evaluation

If all of the following conditions are fulfilled, then the DLC and data field evaluation is successful:

- the DLC of the received CAN frame is equal to the DLC configured in the DLC field of the register SWK\_DLC\_CTRL
- At least one bit within the data field of the received CAN frame is "1" and matches to a bit ("1") of the configured data field. If one bit matches, then the evaluation is stopped. The registers SWK\_DATA0\_CTRL, SWK\_DATA1\_CTRL, SWK\_DATA2\_CTRL, SWK\_DATA3\_CTRL, SWK\_DATA4\_CTRL, SWK\_DATA5\_CTRL, SWK\_DATA6\_CTRL and SWK\_DATA7\_CTRL configure the data field.

**Figure 38** shows an example for the data field evaluation. The DLC in this example is 1.



Figure 38 Data field evaluation



#### **CAN Partial Networking**

## 8.2 Activation of Selective Wake

Figure 39 shows the recommended way to activate the selective wake function in the TLT9255W.



Figure 39 Activation of selective wake function

## 8.3 Frame Error Counter

The frame error counter indicates, whether received classical CAN frames are valid. CAN FD frames are not evaluated and therefore CAN FD frame errors do not affect the frame error counter. If the selective wake unit detects a classical CAN frame error, then the frame error counter is increased by 1. If the selective wake unit



#### **CAN Partial Networking**

detects a valid classical CAN frame, then the error counter is decreased by 1. The following types of errors cause invalid classical CAN Frames:

- Bit stuffing error
- CRC error
- CRC delimiter error

If the SPI bit **SWK\_EN** = 1, then the frame error counter is active in any mode of operation. The error counter value can be read via SPI (register **SWK\_ECNT\_STAT**). Each time that the Selective Wake Unit is enabled (**SWK\_EN** = 1) OR if the  $t_{silence}$  timer has expired, then the error counter is reset to zero.

If the TLT9255W repeatedly receives invalid classical CAN frames in the Selective Wake Sub-Mode, then the frame error counter ensures that a wake-up is performed. If the TLT9255W is in the Selective Wake Sub-Mode and the error counter reaches the value 32, then a wake-up is performed.

## 8.4 Selective Wake Configuration Error

After the microcontroller has confirmed the configuration (**CFG\_VAL** = 1), writing the following registers generates a selective wake configuration error:

- Baudrate control register (SWK\_CTRL\_2)
- Identifier control registers (SWK\_ID3\_CTRL, SWK\_ID2\_CTRL, SWK\_ID1\_CTRL and SWK\_ID0\_CTRL)
- Mask identifier control registers (SWK\_MASK\_ID3\_CTRL, SWK\_MASK\_ID2\_CTRL, SWK\_MASK\_ID1\_CTRL and SWK\_MASK\_ID0\_CTRL)
- Data Length control register (SWK\_DLC\_CTRL)
- Data control registers (SWK\_DATA7\_CTRL, SWK\_DATA6\_CTRL, SWK\_DATA5\_CTRL, SWK\_DATA4\_CTRL, SWK\_DATA3\_CTRL, SWK\_DATA2\_CTRL, SWK\_DATA1\_CTRL and SWK\_DATA0\_CTRL)



#### **CAN Partial Networking**



The following figure shows a selective wake configuration error.

Figure 40 Selective wake configuration Error

## 8.5 CAN Flexible Data Rate (CAN FD) Tolerant Feature

The CAN FD tolerant feature means that selective wake unit ignores CAN FD frames. Therefore it is not possible to configure a CAN FD frame for wake-up frame (WUF) detection.

At the completion of a detected CAN FD frame, that is, the End of Frame (EOF) is detected, the selective wake unit is ready for detecting the next available classical CAN frame. If at least 6 recessive bits and at most 10 recessive bits are received, then EOF detection is successful. The FDF Bit of the Control Field of a CAN FD frame identifies the type of CAN frame:

• FDF bit = 1:

CAN FD frame recognized, decoding stops

• FDF bit = 0:

classical CAN frame recognized, processing of the frame continues

In this way it is possible to send mixed CAN frame formats without affecting the selective wake functionality by error counter increment and a misleading wake-up. The CAN FD data phase baud rate must be configured in the SPI field **BR\_RATIO** of the register **SWK\_CTRL\_2** to enable detection of CAN FD frames.



CAN Partial Networking

## 8.6 Selective wake SPI flags

## 8.6.1 SysErr Flag

The **SysErr** flag in the register **SWK\_STAT** indicates an error condition in the selective wake unit of the TLT9255W. Only if the SPI bit **SWK\_EN** = 1, then the **SysErr** flag is set . The **SysErr** flag does not prevent entering the Sleep Mode by an SPI command. However, the **SysErr** flag determines, whether the TLT9255W enters the Selective Wake Sub-Mode (**SysErr** = 0) or Sleep WUP Mode (**SysErr** = 1). **Figure 41** shows this scenario.



Figure 41 Impact of SysErr flag if a mode change SPI command to Sleep Mode has been sent

The **SysErr** flag is set under any of the following conditions:

- Selective wake configuration error is detected (see **Chapter 8.4**).
- The frame error counter value is greater than 31.

Only if no configuration error (**CFG\_VAL** = 1) exists AND if the error counter is less than 32, then the TLT9255W resets the **SysErr** flag.

## 8.6.2 SYNC Flag

The **SYNC** flag in the register **SWK\_STAT** indicates that a classical CAN frame is detected correctly by the selective wake unit. The **SYNC** flag works, if all of the following conditions are fulfilled:

- Selective Wake is enabled (SWK\_EN Bit = 1)
- After Power on Reset the configuration is confirmed (**CFG\_VAL** Bit = 1) at least once.



#### **CAN Partial Networking**

If the selective wake unit detects an invalid classical CAN frame, then the **SYNC** flag is reset. The **SYNC** flag has no influence on the transition to the Sleep Mode by an SPI command. After power up **SYNC** = 0. The **SYNC** flag is not valid in the Selective Sleep Sub-Mode.

### 8.6.3 CANTO Flag

The **CANTO** flag in the register **SWK\_STAT** indicates that the TLT9255W has entered Selective Sleep Mode (no bus communication) at least once. Only if the SPI bit **SWK\_EN** = 1, then the **CANTO** flag can be set. If the TLT9255W is in the Selective Sleep Mode AND if the  $t_{\text{Silence}}$  timer expires, then the **CANTO** flag is set . Only an SPI command can reset the **CANTO** flag.

### 8.6.4 CANSIL Flag

The **CANSIL** flag in the register **SWK\_STAT** indicates that there is no communication on the CAN bus ( $t_{Silence}$  timer has expired). Figure 15 defines the restart conditions for the  $t_{Silence}$  timer.

### 8.6.5 SWK\_ACTIVE Flag

The **SWK\_ACTIVE** flag in the register **SWK\_STAT** indicates that the TLT9255W is in Selective Wake Sub-Mode. If the TLT9255W enters the Selective Wake Sub-Mode, then the **SWK\_ACTIVE** flag is set. If the TLT9255W exits Sleep Mode, then it resets the **SWK\_ACTIVE** flag.

### 8.6.6 CFG\_VAL Flag

The microcontroller sets the **CFG\_VAL** flag in the register **SWK\_CTRL\_1** to confirm the selective wake configuration. This confirmation must be performed each time before a mode change to Sleep Mode by an SPI command (Selective Wake Sub-Mode) is sent. The TLT9255W resets the **CFG\_VAL** bit under any of the following conditions:

- If a mode change from Selective Wake Sub-Mode to Stand-by Mode is performed.
- If a mode change from Selective Sleep Sub-Mode to Stand-by Mode is performed.
- If a selective wake configuration error is detected (Chapter 8.4).



# 9 Serial Peripheral Interface

The communication between the microcontroller and the transceiver is implemented via Serial Peripheral Interface (SPI). This communication is configured as a full duplex multi slave data transfer. A valid SPI command consists of 16 bits.

Only if  $V_{IO} > V_{IO_{UV}}$  AND if  $V_{BAT}$  OR  $V_{CC}$  is within the functional range, then SPI communication between the microcontroller and the transceiver can be established. The SPI uses four interface signals for synchronization and data transfer:

- CSN: SPI chip select (active low)
- SCLK: SPI clock
- MOSI: SPI data input
- MISO: SPI data output

Figure 42 shows the SPI data transfer.



Figure 42 SPI Data Transfer

The SPI command transmission cycle begins when the transceiver is selected by the CSN pin (active low). When the signal of the CSN input pin returns from "low" to "high", the TLT9255W decodes the data that was shifted in on the MOSI. The data of MOSI and MISO is shifted in and out (MSB comes first) on every rising edge of SCLK. The bit sampling is performed on every falling edge of SCLK. If the CSN input pin is "high", then the MISO pin has a high impedance. The SPI of the transceiver does not support TLT9255W daisy chaining. The MISO pin signals invalid SPI commands (**Chapter 9.5**) or SPI failures (**Chapter 9.4**). If an invalid SPI command OR an SPI failure occurs, then the MISO pin is "high" after the CSN pin is "low" and before a clock starts. **Chapter 9.4** defines the conditions for an SPI Error.



#### Serial Peripheral Interface

### 9.1 SPI command format

An SPI command consists of:

- MOSI request format
- MISO response format

Figure 43 shows the SPI command format.



Figure 43 Command Format of the MOSI and MISO register

#### **MOSI Format Frame**

The MOSI format frame consists of address bits (Bits 14-8) and data bits (Bits 7-0). The R/W bit (Bit15) defines a write operation (R/W = 1) or a read (R/W = 0) operation to the addressed register. For read operations the data bits are not relevant.

#### **MISO Format Frame**

The MISO format frame consists of the status information field (Bits 15-8) and the data bits (Bits 7-0). The data bits contain the data of the addressed register. The status information field contains compressed information about the Status Register (**Chapter 9.3**).



#### **Serial Peripheral Interface**

## 9.2 Control and Status Register

There are two types of registers:

- Control registers:
  - Control the behavior of the TLT9255W, for example mode change and selective wake configuration.
- Status registers:

Status registers represent the status of the TLT9255W, for example wake events and failures. The TLT9255W controls the bits of the status register. However, the microcontroller must reset some of these bits. Writing "1" clears the register (w1c). In case of reading the register the address bits for the register must be set, the R/W bit must be set to 0 and the data bits are not relevant. Writing a "1" to the specific bits in the status register resets the status bits in the status register. **Figure 44** shows this scenario.



Figure 44 Read and clear command



#### **Serial Peripheral Interface**

## 9.3 Status Information Field

The Status Information Field informs the microcontroller that status register bits have changed. The Status Information Field is returned during each SPI write or read command in the MISO format frame. Each bit of the Status Information Field represents an OR operation of some bits of a specific status register. If an SPI access occurs while the status register is being updated due to an event, the content of the Status Information Field may not reflect the latest state of the status registers. **Table 7** defines the content of the Status Information Field.

#### Table 7Status Information Field

Name	<b>Bit Position</b>	Reflected Bits
Reserved	0	-
TRANS_UV_STAT (Transceiver undervoltage status)	1	VBAT_UV OR VCC_LTUV OR VCC_STUV OR VIO_LTUV OR VIO_STUV
TEMP_STAT (Temperature status)	2	TSD OR Reserved
WAKE_STAT (Wake-up status)	3	LWU OR WUP OR WUF
TXD_TO (TxD timeout)	4	TXD_TO
CANSIL (CAN Silence)	5	CANSIL
POR (Power on Reset)	6	POR
ERR_STAT (Error status)	7	CMD_ERR or COM_ERR

The ERR\_STAT is flagged on the MISO pin.

## 9.4 SPI Failure

The SPI bit **COM\_ERR** signals an SPI failure. Any of the following conditions define the SPI failure:

- Register address does not exist
- Number of received SPI clocks is neither 0 nor 16

On SPI failure SPI commands are ignored.

## 9.5 Invalid SPI Command

Any attempt to write undefined bit combinations to one of the following SPI registers is an invalid SPI command.

- Mode of the register MODE\_CTRL
- TXD\_TO of the register TXD\_TO\_CTRL
- **BR\_RATIO** of the register **SWK\_CTRL\_2**
- **BR** of the register **SWK\_CTRL\_2**
- VIO\_UV\_T of the register SUPPLY\_CTRL
- VCC\_UV\_T of the register SUPPLY\_CTRL

An invalid SPI command is ignored and the **CMD\_ERR** bit is set and signalled on the MISO pin. Only the microcontroller can reset the **CMD\_ERR** bit.

## 9.6 CSN Timeout

The CSN timeout ( $t_{CSN_{TO}}$ ) prevents the SPI communication from disturbance. After the CSN pin of the TLT9255W is set to "low" (start of the SPI communication and  $t_{CSN_{TO}}$ ) the communication must be finished



#### Serial Peripheral Interface

and the CSN pin must be set to "high" within  $t_{CSN_{TO}}$ . If the  $t_{CSN_{TO}}$  timeout occurs, then the TLT9255W sets the MISO pin to high impedance. If the CSN pin is set to "high", then the  $t_{CSN_{TO}}$  is reset. **Figure 45** shows this scenario.



Figure 45 CSN Timeout

### 9.7 SPI Register

The following figure gives an overview of the SPI register.

		7	6	5	4	3	2	1	0	15	148
	Register Short Name				Data Bit 158					Access	Addre
		D7	D6	D5	D4	D3	D2	D1	D0	Mode	A14
				сo	NTROL RE	GISTERS					
	MODE_CTRL	reserved	reserved	reserved	reserved		Mo	ode		read/write	00000
	HW_CTRL	STTS_EN	LWU_NEG	LWU_POS	reserved	reserved	reserved	WAKE_TOG	VBAT_CON	read/write	00000
	TXD_TO_CTRL	reserved	reserved	reserved	reserved	reserved	TXD_TO_2	TXD_TO_1	TXD_TO_0	read/write	00000
	SUPPLY_CTRL	VIO_UV_T_3	VIO_UV_T_2	VIO_UV_T_1	VIO_UV_T_0	VCC_UV_T_3	VCC_UV_T_2	VCC_UV_T_1	VCC_UV_T_0	read/write	00001
				SELE	CTIVE WAKE	REGISTERS					
	SWK_CTRL_1	reserved	reserved	reserved	reserved	reserved	reserved	reserved	CFG_VAL	read/write	00001
	SWK_CTRL_2	SWK_EN	reserved	BR_RATIO_1	BR_RATIO_0	reserved	BR_2	BR_1	BR_0	read/write	00001
Ś	SWK_ID3_CTRL	reserved	reserved	IDE	IDE28/ID10	IDE27/ID9	IDE26/ID8	IDE25/ID7	IDE24/ID6	read/write	00001
ter	SWK_ID2_CTRL	IDE23/ID5	IDE22/ID4	IDE21/ID3	IDE20/ID2	IDE19/ID1	IDE18/ID0	IDE17	IDE16	read/write	00010
ji s	SWK_ID1_CTRL	IDE15	IDE14	IDE13	IDE12	IDE11	IDE10	IDE9	IDE8	read/write	00010
Şê	SWK_ID0_CTRL	IDE7	IDE6	IDE5	IDE4	IDE3	IDE2	IDE1	IDE0	read/write	00010
Control Registers	SWK_MASK_ID3_CTRL	reserved	reserved	reserved	MASK_ID28	MASK_ID27	MASK_ID26	MASK_ID25	MASK_ID24	read/write	00010
5 L	SWK_MASK_ID2_CTRL	MASK_ID23	MASK_ID22	MASK_ID21	MASK_ID20	MASK_ID19	MASK_ID18	MASK_ID17	MASK_ID16	read/write	00011
i i	SWK_MASK_ID1_CTRL	MASK_ID15	MASK_ID14	MASK_ID13	MASK_ID12	MASK_ID11	MASK_ID10	MASK_ID9	MASK_ID8	read/write	00011
ŭ	SWK_MASK_ID0_CTRL	MASK_ID7	MASK_ID6	MASK_ID5	MASK_ID4	MASK_ID3	MASK_ID2	MASK_ID1	MASK_ID0	read/write	00011
	SWK_DLC_CTRL	reserved	reserved	reserved	reserved	DLC_3	DLC_2	DLC_1	DLC_0	read/write	00011
	SWK_DATA7_CTRL	DATA7_7	DATA7_6	DATA7_5	DATA7_4	DATA7_3	DATA7_2	DATA7_1	DATA7_0	read/write	00100
	SWK_DATA6_CTRL	DATA6_7	DATA6_6	DATA6_5	DATA6_4	DATA6_3	DATA6_2	DATA6_1	DATA6_0	read/write	00100
	SWK_DATA5_CTRL	DATA5_7	DATA5_6	DATA5_5	DATA5_4	DATA5_3	DATA5_2	DATA5_1	DATA5_0	read/write	00100
	SWK_DATA4_CTRL	DATA4_7	DATA4_6	DATA4_5	DATA4_4	DATA4_3	DATA4_2	DATA4_1	DATA4_0	read/write	00100
	SWK_DATA3_CTRL	DATA3_7	DATA3_6	DATA3_5	DATA3_4	DATA3_3	DATA3_2	DATA3_1	DATA3_0	read/write	00101
	SWK_DATA2_CTRL	DATA2_7	DATA2_6	DATA2_5	DATA2_4	DATA2_3	DATA2_2	DATA2_1	DATA2_0	read/write	00101
	SWK_DATA1_CTRL	DATA1_7	DATA1_6	DATA1_5	DATA1_4	DATA1_3	DATA1_2	DATA1_1	DATA1_0	read/write	00101
	SWK_DATA0_CTRL	DATA0_7	DATA0_6	DATA0_5	DATA0_4	DATA0_3	DATA0_2	DATA0_1	DATA0_0	read/write	00101
				5	STATUS REG	ISTERS					
Registers	TRANS_STAT	POR	reserved	reserved	reserved	reserved	TXD_TO	TSD	reserved	read/clear	00110
ist	TRANS_UV_STAT	VBAT_UV	reserved	VCC_LTUV	VCC_STUV	reserved	reserved	VIO_LTUV	VIO_STUV	read/clear	00110
6a	ERR_STAT	reserved	reserved	reserved	reserved	reserved	reserved	COM_ERR	CMD_ERR	read/clear	00110
Ř	WAKE STAT	reserved	reserved	reserved	reserved	LWU DIR	LWU	WUP	WUF	read/clear	00110
tus		•		SELECTIV	E WAKE STA	TUS REGIST	ERS		•		-
Status	SWK_STAT	reserved	reserved	reserved	SYSERR	SYNC	CANTO	CANSIL	SWK_ACTIVE	read	00111
.,	SWK ECNT STAT	reserved	reserved	ECNT 5	ECNT 4	ECNT 3	ECNT 2	ECNT 1	ECNT 0	read	00111

Figure 46 Register overview



## 9.7.1 Mode Control Register

# MODE\_CTRL

Mode Contro	l		(0)	1 <sub>H</sub> )		Reset	Value:0002 <sub>H</sub>
7	6	5	4	3	2	1	0
	Rese	rved			Мс	de	
<u> </u>	r	W		L L	r	W	

Field	Bits	Туре	Description
Reserved	7:4	rw	Reserved
Mode	3:0	rw	Mode <sup>1)2)</sup>
			0001 <sub>в</sub> , Sleep Mode
			0010 <sub>в</sub> , Standby Mode
			0100 <sub>B</sub> , Receive Only Mode
			1000 <sub>B</sub> , Normal Operation Mode

1) Internal state transitions have higher priority than mode change SPI commands

2) The Mode bits are a reflection of the state of the transceiver which includes internal state transitions

HW_CTRL Hardware Co	ontrol		(0)	2 <sub>H</sub> )		Reset	tValue:00E1 <sub>H</sub>
7	6	5	4	3	2	1	0

S	STTS_EN	LWU_NEG	LWU_POS	Reserved	WAKE_TOG	VBAT_CON
	rw	rw	rw	rw	rw	rw

Field	Bits	Туре	Description
STTS_EN	7	rw	State transition to Sleep WUP Sub-Mode if a V <sub>cc</sub> < V <sub>cc_uv</sub> ANDt > t <sub>vcc_uv_T</sub> AND t <sub>silence</sub> has expired0 <sub>B</sub> , State transition will not be performed1 <sub>B</sub> , State transition will be performed
LWU_NEG	6	rw	Local wake-up direction0B, Local wake-up will not be performed on the negative edge1B, Local wake-up will be performed on the negative edge
LWU_POS	5	rw	Local wake-up direction0B, Local wake-up will not be performed on the positive edge1B, Local wake-up will be performed on the positive edge
Reserved	4:2	rw	Reserved
WAKE_TOG	1	rw	Toggle RxD Pin if a wake-up event is detected0B, The RxD Pin will be constant "low"1B, The RxD Pin will toggle between "low" and "high"



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Field	Bits	Туре	Description			
VBAT_CON	0	rw	Transceiver is connected with the battery         0 <sub>B</sub> , INH pin will not be switched off by entering the sleep mode, $V_{BAT_UV}$ is disabled         LWU is disabled         1 <sub>B</sub> , INH pin will be switched off by entering the sleep mode			
			V <sub>BAT_UV</sub> is enabled LWU is enabled			



### Serial Peripheral Interface

TXD_TO_CTF TXD Timeout			(0)	3 <sub>H</sub> )		Reset	tValue:0001 <sub>H</sub>
7	6	5	4	3	2	1	0
	I	Reserved		I		TXD_TO	
<u> </u>	ł	rw		Į		rw	ļ]

Field	Bits	Туре	Description
Reserved	7:3	rw	Reserved
TXD_TO	2:0	rw	TXD Timeout (min - max)
			001 <sub>B</sub> , 1 - 4 ms
			010 <sub>B</sub> , 2 - 8 ms
			011 <sub>B</sub> , 5 - 10 ms
			100 <sub>B</sub> , disabled

SUPPLY_CTR Supply Conti			(04	4 <sub>H</sub> )		Reset	Value:00CC <sub>H</sub>
7	6	5	4	3	2	1	0
	vio_	UV_T			vcc_	_υν_τ	
<u>.</u>	r	W			r	W	<u> </u>

Field	Bits	Туре	Description
VIO_UV_T	7:4	rw	VIO Undervoltage Detection Timer <sup>1)</sup>
			0001 <sub>B</sub> , 100 ms
			0010 <sub>B</sub> , 200 ms
			0011 <sub>B</sub> , 300 ms
			0100 <sub>B</sub> , 400 ms
			0101 <sub>B</sub> , 500 ms
			0110 <sub>B</sub> , 600 ms
			0111 <sub>B</sub> , 700 ms
			1000 <sub>B</sub> , 800 ms
			1001 <sub>B</sub> , 900 ms
			1010 <sub>B</sub> , 1000 ms
			1011 <sub>B</sub> , 1100 ms
			1100 <sub>B</sub> , 1200 ms
			1101 <sub>B</sub> , 1300 ms
			1110 <sub>B</sub> , 1400 ms
			1111 <sub>B</sub> , 1500 ms



### Serial Peripheral Interface

Field	Bits	Туре	Description	
VCC_UV_T	3:0	rw	VCC Undervoltage Detection Timer <sup>1)</sup>	
			0001 <sub>B</sub> , 100 ms	
			0010 <sub>в</sub> , 200 ms	
			0011 <sub>B</sub> , 300 ms	
			0100 <sub>B</sub> , 400 ms	
			0101 <sub>B</sub> , 500 ms	
			0110 <sub>B</sub> , 600 ms	
			0111 <sub>B</sub> , 700 ms	
			1000 <sub>B</sub> , 800 ms	
			1001 <sub>B</sub> , 900 ms	
			1010 <sub>B</sub> , 1000 ms	
			1011 <sub>B</sub> , 1100 ms	
			1100 <sub>B</sub> , 1200 ms	
			1101 <sub>B</sub> , 1300 ms	
			1110 <sub>B</sub> , 1400 ms	
			1111 <sub>B</sub> , 1500 ms	

1) The derivation of the value can be +/- 40%



## 9.7.2 Selective Wake Control Register

# SWK\_CTRL\_1

Selective Wake Control			(05 <sub>H</sub> )			Reset Value:0000 <sub>H</sub>		
7	6	5	4	3	2	1	0	
			Reserved		· · ·		CFG_VAL	
<u> </u>		I	rw		I <u> </u>		rw	

Field	Bits	Туре	Description
Reserved	7:1	rw	Reserved
CFG_VAL	0	rw	Selective Wake Configuration valid
			0 <sub>B</sub> , Invalid 1 <sub>B</sub> , Valid



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#### SWK\_CTRL\_2 Baudrate Control

Baudrate Control				(06 <sub>H</sub> )				tValue:0004 <sub>H</sub>
	7	6	5	4	3	2	1	0
	SWK_EN	Reserved	BR_R	ΑΤΙΟ	Reserved		BR	
	rw	rw	r	N	rw		rw	J

Field	Bits	Туре	Description
SWK_EN	7	rw	Selective Wake Unit
			0 <sub>B</sub> , Disabled
			1 <sub>B</sub> , Enabled
Reserved	6	rw	Reserved
BR_RATIO	5:4	rw	Baudrate ratio from arbitration phase to CAN FD data phase
			00 <sub>B</sub> , Ratio <= 4
			01 <sub>B</sub> , Ratio <= 10
Reserved	3	rw	Reserved
BR	2:0	rw	Selective Wake Unit Baudrate
			010 <sub>B</sub> , 125 kbit/s <sup>1)</sup>
			011 <sub>B</sub> , 250 kbit/s
			100 <sub>B</sub> , 500 kbit/s
			101 <sub>B</sub> , 1 Mbit/s

1) Glitch filter time is 300 ns in case of ratio 4



	WK_ID3_CT dentifier 3 (			(07	′ <sub>н</sub> )		Reset	tValue:001F <sub>H</sub>
	7	6	5	4	3	2	1	0
	Rese	erved	IDE	'		ID28_24	'	
L	r	w	rw			rw	Į	<u> </u> ]

Field	Bits	Туре	Description			
Reserved	7:6	rw	Reserved			
IDE	5	rw	Identifier Type         0 <sub>B</sub> , Normal Identifier         1 <sub>B</sub> , Extended Identifier			
ID28_24	4:0	rw	Wake-up frame Identifier Note: If a normal Identifier is configured (IDE = 0) the bits ID28 - ID24 define the normal identifier bits ID10 - ID6			

SWK_ID2_C1 Identifier 2 (			(0	8 <sub>H</sub> )		Reset	tValue:00FF <sub>H</sub>
7	6	5	4	3	2	1	0
	ļ	1 1	ID2	3_16	1		
	1	<u>                                      </u>	r	Ŵ	1		

Field	Bits	Туре	Description
ID23_16	7:0	rw	Wake-up frame Identifier
			Note: If a normal Identifier is configured (IDE = 0) the bits ID23 - ID18 define the normal identifier bits ID5 - ID0

SWK_ID1_CT Identifier 1 C			(09	9 <sub>H</sub> )		Rese	tValue:00FF <sub>H</sub>
7	6	5	4	3	2	1	0
			ID1	5_8	, , , , , , , , , , , , , , , , , , ,		
			r	N			

Field	Bits	Туре	Description
ID15_8	7:0	rw	Wake-up frame Identifier



SWK_ID0_CT Identifier 0 C			(0/	A <sub>H</sub> )		Rese	tValue:00FF <sub>H</sub>
7	6	5	4	3	2	1	0
	l	l	ID	7_0	I	T	T
	1	1	r	W	1	1	ļ]

Field	Bits	Туре	Description
ID7_0	7:0	rw	Wake-up frame Identifier

#### SWK\_MASK\_ID3\_CTRL Mask Identifier 3 Control

Mask Identifier 3 Control			(0B <sub>H</sub> )			Reset Value:0000 <sub>H</sub>		
7	6	5	4	3	2	1	0	
	Reserved				Mask_ID28_24			
L	rw				rw			

Field	Bits	Туре	Description
Reserved	7:5	rw	Reserved
Mask_ID28_24	4:0	rw	Mask Identifier

SWK_MASK_ Mask Identif	ID2_CTRL ier 2 Control		(0	C <sub>H</sub> )		Reset	Value:0000 <sub>H</sub>
7	6	5	4	3	2	1	0
		1	MASK_	ID23_16	1		

rw

Field	Bits	Туре	Description
MASK_ID23_16	7:0	rw	Mask Identifier

WK_MASK_ ask Identif	ier 1 Control		(0)	D <sub>H</sub> )		Reset	tValue:0000 <sub>+</sub>
7	6	5	4	3	2	1	0
		' 	MASK_	ID15_8	' 		
	1	1	r	W	1	J	j

Field	Bits	Туре	Description
MASK_ID15_8	7:0	rw	Mask Identifier



SWK_MASK_ Mask Identif	ID0_CTRL ier 0 Control		(0E	: <sub>н</sub> )		Reset	tValue:0000 <sub>H</sub>
7	6	5	4	3	2	1	0
	1		MASK_	ID7_0	Ι		1
	+		rw	V	ļ		ļ]

Field	Bits	Туре	Description
MASK_ID7_0	7:0	rw	Mask Identifier

# SWK\_DLC\_CTRL

Data Length Code Control			(01	<sup>Е</sup> н)		Reset	Value:0000 <sub>H</sub>
7	6	5	4	3	2	1	0
	Resei	rved			DL	.c	
	rv	/	<u> </u>		rv	V	<u> </u>

Field	Bits	Туре	Description
Reserved	7:4	rw	Reserved
DLC	3:0	rw	Data Length Code
			0000 <sub>B</sub> , 0 Data Bytes
			0001 <sub>B</sub> , 1 Data Bytes
			0010 <sub>B</sub> , 2 Data Bytes
			0011 <sub>B</sub> , 3 Data Bytes
			0100 <sub>B</sub> , 4 Data Bytes
			0101 <sub>B</sub> , 5 Data Bytes
			0110 <sub>B</sub> , 6 Data Bytes
			0111 <sub>B</sub> , 7 Data Bytes
			1000 <sub>B</sub> , 8 Data Bytes
			1001 <sub>B</sub> , 8 Data Bytes
			1010 <sub>B</sub> , 8 Data Bytes
			1011 <sub>B</sub> , 8 Data Bytes
			1100 <sub>B</sub> , 8 Data Bytes
			1101 <sub>B</sub> , 8 Data Bytes
			1110 <sub>B</sub> , 8 Data Bytes
			1111 <sub>B</sub> , 8 Data Bytes



SWK_DATA7						
Data 7 Contr	rol		(10 <sub>H</sub> )		Reset	Value:0000 <sub>H</sub>
7	6	5	4 3	2	1	0
			DATA7			
	1	<u>i</u>	rw	<u> </u>	<u>                                     </u>	
Field	Bits	Туре	Description			
DATA7	7:0	rw	Data Byte 7			
SWK_DATA6 Data 6 Contr			(11)		Decet	Valueroooo
			(11 <sub>H</sub> )			Value:0000 <sub>H</sub>
7	6	5	4 3	2	1	0
	1		DATA6	1		
	1		rw		<u> </u>	
			Description			
Field	Bits	Туре	Description			
Field DATA6 SWK DATA5	7:0	rw	Data Byte 6			
DATA6 SWK_DATA5	7:0			2	Reset	<b>Value:0000<sub>H</sub></b> 0
DATA6 SWK_DATA5 Data 5 Contr	7:0 _CTRL rol	rw	Data Byte 6 (12 <sub>H</sub> )	2		
DATA6 SWK_DATA5 Data 5 Contr	7:0 _CTRL rol	rw	<b>Data Byte 6</b> (12 <sub>H</sub> ) 4 3	2		
DATA6 SWK_DATA5 Data 5 Contr 7	7:0 _CTRL rol	5	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5 rw	2		
DATA6 SWK_DATA5 Data 5 Contr 7 Field	7:0 _CTRL rol 6	rw	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5	2		
DATA6 SWK_DATA5 Data 5 Contr 7 Field DATA5 SWK_DATA4	7:0	5 7 7 7 7 7 7 7 7 7 7	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5 rw Pescription	2		
DATA6 SWK_DATA5 Data 5 Contr 7 Field DATA5 SWK_DATA4	7:0	5 7 7 7 7 7 7 7 7 7 7	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5 rw Description Data Byte 5	2		0
DATA6 SWK_DATA5 Data 5 Contr 7 Field DATA5 SWK_DATA4 Data 4 Contr	7:0 _CTRL 6 Bits 7:0	Type rw	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5 rw Description Data Byte 5 (13 <sub>H</sub> )		1 Reset	0 Value:0000 <sub>H</sub>
DATA6 SWK_DATA5 Data 5 Contr 7 Field DATA5 SWK_DATA4 Data 4 Contr	7:0 _CTRL 6 Bits 7:0	Type rw	Data Byte 6 (12 <sub>H</sub> ) 4 3 DATA5 rw Description Data Byte 5 (13 <sub>H</sub> ) 4 3		1 Reset	0 Value:0000 <sub>H</sub>
DATA6 SWK_DATA5 Data 5 Contr 7 Field DATA5 SWK_DATA4 Data 4 Contr	7:0 _CTRL 6 Bits 7:0	Type rw	Data Byte 6 (12 <sub>H</sub> ) (12 <sub>H</sub> ) (12 <sub>H</sub> ) (13 <sub>H</sub> ) (1		1 Reset	0 Value:0000 <sub>H</sub>



	_CTRL					
Data 3 Contr	ol		(14 <sub>H</sub> )		Reset	/alue:0000 <sub>H</sub>
7	6	5	4 3	2	1	0
			DATA3			
	ļ.		rw		1 1	
Field	Bits	Туре	Description			
DATA3	7:0	rw	Data Byte 3			
SWK_DATA2 Data 2 Contr			(15 <sub>H</sub> )		Reset	/alue:0000 <sub>H</sub>
7	6	5	4 3	2	1	0
			DATA2			
	I	1	rw	1	11	
Field	Bits	Туре	Description			
DATA2	7:0	rw	Data Byte 2			
CWW DATA1	CTDI					
		5	<b>(16<sub>H</sub>)</b> 4 3	2	Reset V	/alue:0000 <sub>H</sub>
Data 1 Contr	ol	5		2		
Data 1 Contr	ol	5	4 3	2		
Data 1 Contr 7	ol		4 3 DATA1	2		
Data 1 Contr 7 Field	rol 6	5 - - - - - - - - - - - - - - - - - - -	4 3 DATA1 rw	2		
7 Field DATA1 SWK_DATA0 Data 0 Contr	rol 6 Bits 7:0 _CTRL rol	<b>Type</b> rw	4 3 DATA1 rw Description Data Byte 1 (17 <sub>H</sub> )		1 Reset V	0 /alue:0000 <sub>H</sub>
7 Field DATA1 SWK_DATA0	rol 6 Bits 7:0	Туре	4 3 DATA1 rw Description Data Byte 1 (17 <sub>H</sub> ) 4 3	2	1	0
7 Field DATA1 SWK_DATA0 Data 0 Contr	rol 6 Bits 7:0 _CTRL rol	<b>Type</b> rw	4 3 DATA1 rw Description Data Byte 1 (17 <sub>H</sub> )		1 Reset V	0 /alue:0000 <sub>H</sub>
7 Field DATA1 SWK_DATA0 Data 0 Contr	rol 6 Bits 7:0 _CTRL rol	<b>Type</b> rw	4 3 DATA1 rw Description Data Byte 1 (17 <sub>H</sub> ) 4 3 DATA0		1 Reset V	0 /alue:0000 <sub>H</sub>



## 9.7.3 Status Register

# TRANS\_STAT

Transceiver	Fransceiver Status (18 <sub>H</sub> )					Rese	tValue:0000 <sub>H</sub>
7	6	5	4	3	2	1	0
POR		Rese	rved		TXD_TO	TSD	Reserved
w1c		W	lc		w1c	w1c	w1c

Field	Bits	Туре	Description
POR	7	w1c	Power On Reset         0 <sub>B</sub> , No POR occurred         1 <sub>B</sub> , POR occurred
Reserved	6:3	w1c	Reserved
TXD_TO	2	w1c	TxD Timeout0B, No TxD timeout detected1B, TxD timeout detected
TSD	1	w1c	CAN Thermal Shut Down 0 <sub>B</sub> , No Thermal Shut Down detected 1 <sub>B</sub> , Thermal Shut Down detected
Reserved	0	w1c	Reserved

TRANS_UV_S Transceiver (		e Status	(19	Э <sub>н</sub> )		Reset	Value:0000 <sub>H</sub>	
7	6	5	4	3	2	1	0	
	Peserved			Pasa	rved			

VBAT_UV	Reserved	VCC_LTUV	VCC_STUV	Reserved	VIO_LTUV	νιο_sτυν
w1c	w1c	w1c	w1c	wlc	w1c	w1c

Field	Bits	Туре	Description
VBAT_UV	7	w1c	Battery Undervoltage detected0B, No battery undervoltage detected1B, Battery undervoltage detected
Reserved	6	w1c	Reserved
	5	w1c	$V_{cc}$ long-term undervoltage detection $0_B$ , No $V_{cc}$ long-term undervoltage detected $1_B$ , $V_{cc}$ long-term undervoltage detected
VCC_STUV	4	w1c	<ul> <li>V<sub>cc</sub> short-term undervoltage detection</li> <li>0<sub>B</sub> , No V<sub>cc</sub> short-term undervoltage detected</li> <li>1<sub>B</sub> , V<sub>cc</sub> short-term undervoltage detected</li> </ul>
Reserved	3:2	w1c	Reserved
VIO_LTUV	1	w1c	$\begin{array}{lll} \textbf{V}_{\text{IO}} \mbox{ long-term undervoltage detection} \\ \textbf{0}_{\text{B}} & , \mbox{ No V}_{\text{IO}} \mbox{ long-term undervoltage detected} \\ \textbf{1}_{\text{B}} & , \mbox{ V}_{\text{IO}} \mbox{ long-term undervoltage detected} \end{array}$



## Serial Peripheral Interface

Field	Bits	Туре	Description
VIO_STUV	0	w1c	V <sub>10</sub> short-term undervoltage detection
			0 <sub>B</sub> , No V <sub>IO</sub> short-term undervoltage detected
			$1_B$ , $V_{IO}$ short-term undervoltage detected

# ERR\_STAT

Error Status			(1/	Reset Value:0000 <sub>H</sub>			
7	6	5	4	3	2	1	0
		COM_ERR	CMD_ERR				
	+	W	1c	Į		w1c	w1c

Field	Bits	Туре	Description
Reserved	7:2	w1c	Reserved
COM_ERR	1	w1c	SPI failure detected (Chapter 9.4) 0 <sub>B</sub> , No SPI failure detected 1 <sub>B</sub> , SPI failure detected
CMD_ERR	0	w1c	Invalid SPI Command (Chapter 9.5) 0 <sub>B</sub> , No invalid SPI command received 1 <sub>B</sub> , Invalid SPI command received

## WAKE\_STAT

Wake Status					LB <sub>H</sub> )		Reset Value:0000 <sub>H</sub>		
	7	6	5	4	3	2	1	0	
		Rese	erved		LWU_DIR	LWU	WUP	WUF	
		W	1c	1	r	wlc	w1c	w1c	

Field	Bits	Туре	Description
Reserved	7:4	w1c	Reserved
LWU_DIR	3	r	Local Wake-Up Direction $0_B$ , Local Wake-Up has been performed by the falling edge $1_B$ , Local Wake-Up has been performed by the rising edge
LWU	2	w1c	Local Wake-Up 0 <sub>B</sub> , No Local Wake-Up performed 1 <sub>B</sub> , Local Wake-Up performed
WUP	1	w1c	Wake-Up Pattern0B, No Wake-Up Pattern detected1B, Wake-Up Pattern detected
WUF	0	w1c	Wake-Up Frame0B, No Wake-Up Frame detected1B, Wake-Up Frame detected



#### SWK\_STAT Selective Wake Statu

Selective Wake Status				(10	С <sub>н</sub> )	ResetValue:0002 <sub>H</sub>		
	7	6	5	4	3	2	1	0
		Reserved	1	SysErr	SYNC	CANTO	CANSIL	SWK_ACTIVE
L		wlc		r	r	w1c	r	r

Field	Bits	Туре	Description						
Reserved	7:5	w1c	Reserved						
SysErr	4	r	System Error         0 <sub>B</sub> , No System Error detected         1 <sub>B</sub> , System Error detected						
SYNC	3	r	Synchronisation of the Selective Wake Unit0B, SWK Unit is not synchronous to the CAN bit stream1B, SWK Unit is synchronous to the CAN bit stream						
CANTO	2	w1c	CAN Timeout0B, Transceiver has not entered the Selective Sleep Sub-Mode1B, Transceiver has entered the Selective Sleep Sub-Mode at least once in Sleep Mode						
CANSIL	1	r	CAN Silence0B, Transceiver is not in the Selective Sleep Mode1B, Transceiver is in the Selective Sleep Mode (No CAN bus communication)						
SWK_ACTIVE	0	r	Selective Wake0B, Transceiver is not in the Selective Wake Mode1B, Transceiver is in the Selective Wake Mode						

#### SWK\_ECNT\_STAT Error Counter Status

			•	117			
7	6	5	4	3	2	1	0
Rese	rved			EC	NT	Ι	
	r			l	·	1	<u> </u>

(1D<sub>u</sub>)

Field	Bits	Туре	Description
Reserved	7:6	r	Reserved
ECNT	5:0	r	Error Counter Value

Reset Value:0000



**Electrical Characteristics** 

# **10 Electrical Characteristics**

## 10.1 General Timing Parameter

#### Table 8 General Timing Parameter

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Power up delay time	t <sub>PON</sub>	_	-	1	ms	-	P_10.1.1
Delay time for mode change	t <sub>Mode_Change</sub>	-	-	20	μs	-	P_10.1.2
CAN Bus Silence timeout	t <sub>Silence</sub>	0.6	-	1.2	s	-	P_10.1.3

### **10.2** Power Supply Interface

#### 10.2.1 Current Consumption

#### Table 9Current Consumption

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or	Number		
		Min.	Тур.	Max.		<b>Test Condition</b>		
Normal-operating Mode					H	-		
<i>V</i> <sub>BAT</sub> supply current	I <sub>BAT_NM</sub>	-	0.8	1.3	mA	INH = not connected;	P_10.2.1	
V <sub>cc</sub> supply current dominant bus signal	I <sub>CC_NM_D</sub>	-	35	45	mA	-	P_10.2.2	
V <sub>cc</sub> supply current recessive bus signal	I <sub>CC_NM_R</sub>	-	0.9	4.0	mA	-	P_10.2.3	
V <sub>IO</sub> supply current	I <sub>IO_NM</sub>	-	0.2	0.5	mA	-	P_10.2.4	
Receive-only Mode								
$V_{\text{BAT}}$ and $V_{\text{CC}}$ supply current $I_{\text{BAT}\_\text{CC}\_\text{ROM}} = I_{\text{BAT}} + I_{\text{CC}}$	I <sub>BAT_CC_ROM</sub>	-	0.9	1.3	mA	INH = not connected;	P_10.2.5	
V <sub>cc</sub> supply current	I <sub>CC_ROM</sub>	-	0.8	1.3	mA	V <sub>BAT</sub> = not connected;	P_10.2.6	
V <sub>IO</sub> supply current	I <sub>IO_ROM</sub>	-	2	20	μA	-	P_10.2.7	



#### **Electrical Characteristics**

#### Table 9Current Consumption (cont'd)

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Stand-by Mode							
V <sub>BAT</sub> and V <sub>CC</sub> supply current I <sub>BAT_CC_STB</sub> = I <sub>BAT</sub> + I <sub>CC</sub>	I <sub>BAT_CC_STB</sub>	-	260	320	μΑ	T <sub>J</sub> = 85°, INH = not connected, WAKE pin = GND, SPI Bit <b>SWK_EN</b> = "0", No CAN Bus communication;	P_10.2.8
V <sub>BAT</sub> and V <sub>CC</sub> supply current I <sub>BAT_CC_STB</sub> = I <sub>BAT</sub> + I <sub>CC</sub>	I <sub>BAT_CC_STB</sub>	-	300	365	μΑ	INH = not connected, WAKE pin = GND, SPI Bit <b>SWK_EN</b> = "0", No CAN Bus communication;	P_10.2.21
V <sub>cc</sub> supply current	I <sub>CC_STB</sub>	-	260	320	μΑ	$T_J = 85^\circ$ , $V_{BAT} = not$ connected, WAKE pin = GND, SPI Bit SWK_EN = "0", No CAN Bus communication;	P_10.2.9
V <sub>cc</sub> supply current	I <sub>CC_STB</sub>	-	300	365	μΑ	V <sub>BAT</sub> = not connected, WAKE pin = GND, SPI Bit <b>SWK_EN</b> = "0", No CAN Bus communication;	P_10.2.38
V <sub>IO</sub> supply current	I <sub>IO_STB</sub>	-	2.0	5.0	μA	-	P_10.2.10
Sleep WUP Sub-Mode Selective-sleep Sub-Mode							
V <sub>BAT</sub> supply current	I <sub>BAT_SLP</sub>	-	18.0	30.0	μΑ	V <sub>CC</sub> = V <sub>IO</sub> = 0 V, bus biasing = GND, INH = not connected,	P_10.2.11

5.5 V < V<sub>BAT</sub> < 18 V, -40°C < T<sub>J</sub> < 150°C;



#### **Electrical Characteristics**

#### Table 9Current Consumption (cont'd)

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.	1	Test Condition	
V <sub>BAT</sub> supply current	I <sub>BAT_SLP</sub>	-	12.0	20.0	μΑ	$V_{CC} = V_{IO} = 0 V,$ bus biasing = GND, INH = not connected, $5.5 V < V_{BAT} < 18 V,$ $-40^{\circ}C < T_{J} < 125^{\circ}C;$	P_10.2.35
<i>V</i> <sub>cc</sub> supply current	I <sub>CC_SLP</sub>	-	0.3	5.0	μA	CSN, TxD= $V_{IO}$ , MOSI, SCLK = GND, $V_{BAT}$ = 12 V;	P_10.2.12
V <sub>IO</sub> supply current	I <sub>IO_SLP</sub>	-	2.0	5.0	μA	CSN, TxD= V <sub>IO</sub> , MOSI, SCLK = GND;	P_10.2.13



#### **Electrical Characteristics**

#### Table 9Current Consumption (cont'd)

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Selective-wake mode	H	- I			L.		
V <sub>BAT</sub> supply current	I <sub>BAT_SEL_WK</sub>	-	590	705	μΑ	$V_{CC} = V_{IO} = 0 V$ , INH = not connected, 500 kbit/s with 100% bus load, Classical CAN Frame: Id = 0x4C7 DLC = 3 Data = 0xC7, 0x8E, 0x68;	P_10.2.14
V <sub>BAT</sub> supply current	IBAT_SEL_WK	-	550	650	μΑ	$V_{cc} = V_{IO} = 0 V,$ $T_J = 85^{\circ}C,$ INH = not connected, 500 kbit/s with 100% bus load, Classical CAN Frame: Id = 0x4C7 DLC = 3 Data = 0xC7, 0x8E, 0x68;	P_10.2.39
V <sub>CC</sub> supply current	I <sub>CC_SEL_WK</sub>	-	0.4	5.0	μΑ	CSN, TxD= $V_{IO}$ , MOSI, SCLK = GND, $V_{BAT}$ = 12 V;	P_10.2.16
V <sub>IO</sub> supply current	I <sub>IO_SEL_WK</sub>	-	2.0	5.0	μA	CSN, TxD= V <sub>IO</sub> , MOSI, SCLK = GND;	P_10.2.17



#### **Electrical Characteristics**

## **10.2.2** Undervoltage Detection

#### Table 10 Undervoltage Detection

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Values	5	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Undervoltage Detection V <sub>E</sub>	AT						I
Undervoltage detection threshold	V <sub>BAT_UV</sub>	4.2	5.0	5.5	V	1)	P_10.2.18
Power down threshold	V <sub>BAT_POD</sub>	3	4.0	4.4	V	<sup>1)</sup> , falling edge, V <sub>CC</sub> = 0 V;	P_10.2.20
Undervoltage glitch filter	t <sub>VBAT_filter</sub>	1	-	400	μs	(see Figure 24)	P_10.2.22
Undervoltage Detection V <sub>c</sub>				<u>.</u>			
Undervoltage detection threshold	V <sub>cc_uv</sub>	4.5	4.65	4.75	V	-	P_10.2.23
Power down threshold	V <sub>CC_POD</sub>	2.5	3	4.0	V	falling edge, V <sub>BAT</sub> = 0 V;	P_10.2.25
Undervoltage glitch filter	t <sub>VCC_filter</sub>	1	-	10	μs	(see Figure 26)	P_10.2.27
Transmitter recovery time	t <sub>VCC_recovery</sub>			20	μs	(see Figure 26)	P_10.2.36
Response time V <sub>cc</sub> for long-term undervoltage detection	t <sub>vcc_uv_t</sub>	0.6 х <i>V</i> <sub>сс_uv_т</sub>	-	1.4 х <i>V</i> <sub>сс_UV_</sub> т		Adjustable by SPI bit VCC_UV_T (see Figure 28 and Figure 29)	P_10.2.28
Undervoltage Detection V	0						I
Undervoltage detection threshold	V <sub>IO_UV</sub>	2.4	2.6	3.0	V	-	P_10.2.29
Undervoltage glitch filter	t <sub>VIO_filter</sub>	1	-	10	μs	(see Figure 30)	P_10.2.31
Transmitter recovery time	t <sub>VIO_recovery</sub>			20	μs	(see Figure 30)	P_10.2.37
Response time V <sub>IO</sub> for long-term undervoltage detection	t <sub>vio_uv_t</sub>	0.6 x V <sub>IO_UV_T</sub>	-	1.4 x V <sub>IO_UV_T</sub>		Adjustable by SPI field VIO_UV_T (see Figure 32 and Figure 33)	P_10.2.32

1) The design of the TLT9255W guarantees that the V<sub>Bat</sub> powerdown threshold is below the V<sub>Bat</sub> undervoltage threshold


**Electrical Characteristics** 

## 10.2.3 INH Output

### Table 11 INH Output

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	5	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Analog Output INH							
Output voltage INH enabled	V <sub>INH</sub>	V <sub>BAT</sub> - 0.8	-	-	V	<ul> <li><i>I</i><sub>INH</sub> = -0.2 mA,</li> <li>Normal-operating</li> <li>Mode</li> <li>Receive-only Mode</li> <li>Stand-by Mode;</li> </ul>	P_10.2.33
Absolute leakage current	I <sub>INH_Leak</sub>	-5.0	-	-	μΑ	V <sub>INH</sub> = 0 V, Sleep Mode;	P_10.2.34

# 10.3 CAN Controller Interface

### Table 12CAN Controller Interface

 $4.75 \text{ V} < V_{\text{CC}} < 5.25 \text{ V}; 3.0 \text{ V} < V_{\text{IO}} < 5.5 \text{ V}; 5.5 \text{ V} < V_{\text{BAT}} < 40 \text{ V}; R_{\text{L}} = 60 \Omega; t_{\text{Bit(min)}} = 500 \text{ ns}; t_{\text{Bit(Flash)}} = 200 \text{ ns}; -40 \text{ °C} < T_{\text{J}} < 150 \text{ °C};$ 

all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	S	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Receiver Output RxD					L		
"high" level output current	I <sub>RxD_H</sub>	-	-1.8	-1.0	mA	$V_{\text{RxD}} = V_{\text{IO}} - 0.4 \text{ V},$ $V_{\text{Diff}} < 0.5 \text{V};$	P_10.3.1
"low" level output current	I <sub>RxD_L</sub>	1.0	1.8	-	mA	$V_{\text{RxD}} = 0.4 \text{ V},$ $V_{\text{Diff}} > 0.9 \text{V};$	P_10.3.2
RxD toggling time after wake-up event	$t_{ m Toggle}$	6	-	14	ms	see Chapter 6.8.2	P_10.3.6
Transmitter Input TxD					L		
"high" level input voltage threshold	V <sub>TxD_H</sub>	-	0.5 x V <sub>IO</sub>	0.7 x V <sub>IO</sub>	V	recessive state;	P_10.3.7
"low" level input voltage threshold	V <sub>TxD_L</sub>	0.3 x V <sub>IO</sub>	0.4 x V <sub>IO</sub>	-	V	dominant state;	P_10.3.8
"high" level input current	I <sub>TxD_H</sub>	-2.0	-	2.0	μA	$V_{\text{TxD}} = V_{\text{IO}};$	P_10.3.10
"low" level input current	I <sub>TxD_L</sub>	-220	-	-20.0	μA	$V_{\text{TxD}} = 0 \text{ V};$	P_10.3.11



## **Electrical Characteristics**

## Table 12 CAN Controller Interface (cont'd)

 $4.75 \text{ V} < V_{\text{CC}} < 5.25 \text{ V}; 3.0 \text{ V} < V_{\text{IO}} < 5.5 \text{ V}; 5.5 \text{ V} < V_{\text{BAT}} < 40 \text{ V}; R_{\text{L}} = 60 \Omega; t_{\text{Bit(min)}} = 500 \text{ ns}; t_{\text{Bit(Flash)}} = 200 \text{ ns}; t_$ 

all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	5	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
TxD permanent dominant timeout	t <sub>txd_to</sub>	1	_	4	ms	Default value is 001 <sub>B</sub> in TXD_TO_CTRL Adjustable by SPI register <b>TXD_TO_CTRL</b>	P_10.3.12
Input capacitance	C <sub>TxD</sub>	-	-	10	pF	1)	P_10.3.13

1) Not subject to production test, specified by design.



**Electrical Characteristics** 

# 10.4 Transmitter and Receiver

# 10.4.1 Transmitter

### Table 13 Transmitter

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Bus Transmitter				·		•	
CANH, CANL recessive output voltage	V <sub>CANL/H</sub>	2.0	2.5	3.0	V	Normal-operating Mode, Receive-only Mode, Selective Wake Sub- Mode;	P_10.4.1
CANH, CANL recessive output voltage difference	$V_{\text{Diff}_R_NM} = V_{\text{CANH}} - V_{\text{CANL}}$	-500	-	50	mV	$V_{\text{TxD}} = V_{\text{IO}},$ no load;	P_10.4.2
CANH dominant output voltage Normal-operating Mode	V <sub>CANH</sub>	2.75	-	4.5	V	$V_{TxD} = 0 V,$ 50 $\Omega < R_L < 65 \Omega;$	P_10.4.3
CANL dominant output voltage Normal-operating Mode	V <sub>CANL</sub>	0.5	_	2.25	V	$V_{\text{TxD}} = 0 \text{ V},$ 50 \Omega < R_L < 65 \Omega;	P_10.4.4
CANH dominant output voltage difference: V <sub>Diff_D</sub> = V <sub>CANH</sub> - V <sub>CANL</sub> Normal-operating Mode	V <sub>Diff_D</sub>	1.5	2.0	3.0	V	$V_{T \times D} = 0 V,$ 50 $\Omega < R_L < 65 \Omega;$	P_10.4.5
CANH dominant output voltage difference extended bus load V <sub>Diff_D</sub> = V <sub>CANH</sub> - V <sub>CANL</sub> Normal-operating Mode	V <sub>Diff_D_EXT_BL</sub>	1.4	-	3.3	V	$V_{T \times D} = 0 V,$ $R_{L} = 45 \Omega < R_{L} < 70 \Omega$	P_10.4.6
CANH, CANL dominant output voltage difference high extended bus load Normal-operating mode $V_{\text{Diff}} = V_{\text{CANH}} - V_{\text{CANL}}$	V <sub>Diff_D_HEXT_BL</sub>	1.5	-	5.0	V	$V_{TxD} = 0 V,$ $R_{L} = 2240 \Omega^{1};$	P_10.4.7



## **Electrical Characteristics**

## Table 13Transmitter (cont'd)

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
CANH, CANL recessive output voltage Sleep WUP Sub-Mode, Selective sleep Sub-Mode	V <sub>CANL_H</sub>	-0.1	_	0.1	V	no load;	P_10.4.10
CANH, CANL recessive output voltage difference Sleep WUP Sub-Mode, Selective sleep Sub-Mode	V <sub>Diff_SLP</sub>	-0.2	_	0.2	V	no load;	P_10.4.11
Driver symmetry $V_{\text{SYM}} = V_{\text{CANH}} + V_{\text{CANL}}$	V <sub>SYM</sub>	0.9 x V <sub>cc</sub>	1.0 x V <sub>CC</sub>	1.1 x V <sub>CC</sub>	V	Split termination, $R_L = 60$ Ohm, C = 4.7 nF, $^{(1)2)}$	P_10.4.12
CANH short circuit current	I <sub>CANHSC</sub>	115	-	-115	mA	-3 =< V <sub>CAN</sub> =< 18 V, t < <b>TXD_TO</b> , V <sub>TXD</sub> = 0 V;	P_10.4.13
CANL short circuit current	I <sub>CANLSC</sub>	-115	-	115	mA	-3 =< V <sub>CAN</sub> =< 18 V, t < <b>TXD_TO</b> , V <sub>TXD</sub> = 0 V;	P_10.4.14
Leakage current CANH	I <sub>CANH_Ik</sub>	-5	-	5	μΑ	$V_{CC} = V_{IO} = V_{BAT} = 0 V^{3}$ , $0 V < V_{CANH} < 5 V$ ; $V_{CANH} = V_{CANL}$ ;	P_10.4.16
Leakage current CANL	I <sub>CANL_Ik</sub>	-5	-	5	μΑ	$V_{CC} = V_{IO} = V_{BAT} = 0 V^{3},$ $0 V < V_{CANL} < 5 V;$ $V_{CANH} = V_{CANL};$	P_10.4.17

1) Not subject to production test, specified by design

2) V<sub>SYM</sub> shall be observed during dominant and recessive state and also during the transition from dominant to recessive and vice versa, while TxD is stimulated by a square wave signal with a frequency of 62,5 kHz (125 kbit/s), 125 kHz (250 kbit/s), 250 kHz (500 kbit/s), 500 kHz (1 Mbit/s), 1 MHz (2 Mbit/s), 2,5 MHz (5 Mbit/s)

3) Additional requirement  $V_{10} = V_{CC}$  connected via 47 k $\Omega$  to GND



#### **Electrical Characteristics**

## 10.4.2 Receiver

#### Table 14 Receiver

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Bus Receiver							1
Common Mode Range	V <sub>CMR</sub>	-12	-	12	V	-	P_10.4.18
Differential range dominant Normal-operating Mode Receive-only Mode Selective Wake SUB-Mode	$V_{\rm Diff_D_Range}$	0.9	-	8.0	V	V <sub>CMR</sub> Bus Biasing on, <sup>1)</sup> ;	P_10.4.21
Differential range recessive Normal-operating Mode, Receive-only Mode Selective Wake SUB-Mode	V <sub>Diff_R_Range</sub>	-3.0	-	0.5	V	V <sub>CMR</sub> Bus Biasing on, <sup>1)</sup> ;	P_10.4.23
Single ended internal resistance	R <sub>CAN_H,</sub> R <sub>CAN_L</sub>	6	37	50	kΩ	$\begin{array}{l} -2V \leq V_{CAN_H} \leq 7 \text{ V}, \\ -2V \leq V_{CAN_L} \leq 7 \text{ V}, \\ \text{recessive state;} \end{array}$	P_10.4.25
Input resistance deviation between CANH and CANL	ΔR <sub>i</sub>	-3.0	-	3.0	%	$V_{CAN_L} = V_{CAN_H} = 5 V,$ $V_{CC} = 5 V,$ recessive state;	P_10.4.26
Differential internal resistance	R <sub>Diff</sub>	12	75	100	kΩ	$-2V \le V_{CAN_H} \le 7 V,$ $-2V \le V_{CAN_L} \le 7 V,$ recessive state;	P_10.4.27
Input capacitance CANH, CANL versus GND	C <sub>In</sub>	-	-	40	pF	1)	P_10.4.28
Differential input capacitance	C <sub>InDiff</sub>	-	-	20	pF	1)	P_10.4.29

1) Not subject to production test, specified by design.



**Electrical Characteristics** 

# 10.4.3 Dynamic Transceiver Parameter

### Table 15 Propagation Delay

Parameter	Symbol		Value	S	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Propagation Delay Chai	racteristic						
Propagation delay, TxD to RxD	t <sub>Loop</sub>	80	160	255	ns	C <sub>L</sub> = 100 pF, C <sub>RxD</sub> = 15 pF; (see <b>Figure 48</b> )	P_10.4.30
Propagation delay, increased load, TxD to RxD	<i>t</i> <sub>Loop_150</sub>	80	-	330	ns	$C_{L} = 100 \text{ pF},$ $C_{R\times D} = 15 \text{ pF},$ $R_{L} = 150 \Omega;$ (see <b>Figure 48</b> )	P_10.4.31
Propagation delay, TxD to bus ("low" to dominant)	t <sub>d(L),T</sub>	30	85	140	ns	C <sub>L</sub> = 100 pF, C <sub>RxD</sub> = 15 pF; (see <b>Figure 48</b> )	P_10.4.32
Propagation delay, TxD to bus ("high" to recessive)	t <sub>d(H),T</sub>	30	90	140	ns	C <sub>L</sub> = 100 pF, C <sub>RxD</sub> = 15 pF; (see <b>Figure 48</b> )	P_10.4.33
Propagation delay, bus to RxD (dominant to "low")	$t_{d(L),R}$	30	75	140	ns	C <sub>RxD</sub> = 15 pF; (see <b>Figure 48</b> )	P_10.4.34
Propagation delay, bus to RxD (recessive to "high")	t <sub>d(H),R</sub>	30	105	140	ns	C <sub>RxD</sub> = 15 pF; (see <b>Figure 48</b> )	P_10.4.35



## **Electrical Characteristics**

## Table 16 CAN FD

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
CAN FD Characteristics	1	1	ł	U		I	
Received recessive bit width at 2 MBit/s	t <sub>Bit(RxD)_2M</sub>	400	500	550	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 500 \text{ ns},;$ (see <b>Figure 49</b> );	P_10.4.36
Received recessive bit width at 5 MBit/s	t <sub>Bit(RxD)_5M</sub>	120	200	220	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 200 \text{ ns};$ (see <b>Figure 49</b> );	P_10.4.37
Transmitted recessive bit width at 2 MBit/s	t <sub>Bit(Bus)_2M</sub>	435	500	530	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 500 \text{ ns};$ (see <b>Figure 49</b> );	P_10.4.38
Transmitted recessive bit width at 5 MBit/s	t <sub>Bit(Bus)_5M</sub>	155	200	210	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 200 \text{ ns};$ (see <b>Figure 49</b> );	P_10.4.39
Receiver timing symmetry at 2 MBit/s $\Delta t_{\text{Rec}_{2M}} = t_{\text{Bit}(\text{RxD})_{2M}} - t_{\text{Bit}(\text{Bus})_{2M}}$	$\Delta t_{\rm Rec_{2M}}$	-65	-	40	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 500 \text{ ns},$ (see <b>Figure 49</b> );	P_10.4.40
Receiver timing symmetry at 5 MBit/s $\Delta t_{\text{Rec}_{5M}} = t_{\text{Bit}(\text{RxD})_{5M}} - t_{\text{Bit}(\text{Bus})_{5M}}$	$\Delta t_{\rm Rec_{5M}}$	-45	-	15	ns	$C_{L} = 100 \text{ pF},$ $C_{RxD} = 15 \text{ pF},$ $t_{Bit} = 200 \text{ ns},$ (see <b>Figure 49</b> );	P_10.4.41



## **Electrical Characteristics**



Figure 47 Test Circuit for dynamic characteristics



Figure 48 Timing diagrams for dynamic characteristics



## **Electrical Characteristics**



Figure 49 Recessive bit time for five dominant bits followed by one recessive bit



**Electrical Characteristics** 

## **10.5** Selective Wake Parameter

# 10.5.1 General Timings

### Table 17 Electrical Characteristics: CAN FD

Parameter	Symbol	ymbol Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Network propagation delay	t <sub>Net_Prop_125</sub>	-400	-	5450	ns	Baudrate = 125 kBit/sec;	P_10.5.1
Network propagation delay	t <sub>Net_Prop_250</sub>	-200	-	2675	ns	Baudrate = 250 kBit/sec;	P_10.5.2
Network propagation delay	t <sub>Net_Prop_500</sub>	-100	-	1350	ns	Baudrate = 500 kBit/sec;	P_10.5.3
Network propagation delay	t <sub>Net_Prop_1000</sub>	-50	-	550	ns	Baudrate = 1 MBit/sec;	P_10.5.4



### **Electrical Characteristics**

## 10.5.2 CAN FD Tolerance

#### Table 18 Electrical Characteristics: CAN FD

Parameter	Symbol		Values		Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
dominant signal which must be ignored and interpreted as a glitch	t <sub>FD_Glitch_4</sub>	0	-	0.05 x t <sub>arbitratio</sub> n		Ratio ≤ 4, up to 2MBit/s;	P_10.5.5
dominant signal which must be detected as a data bit after the FDF bit and before EOF bit	t <sub>FD_DOM_4</sub>	t <sub>arbitratio</sub> n x 0.175	-	-		Ratio ≤ 4, up to 2MBit/s;	P_10.5.7



**Electrical Characteristics** 

10.6 Wake-Up

## 10.6.1 General Timings

### Table 19General Timings

Parameter	Symbol		Values			Note or	Number
		Min.	Тур.	Max.		Test Condition	
INH wake-up delay time	t <sub>wu_inh</sub>	-	-	30.0	μs	$V_{BAT} = 14.0V,$ $R_{INH} = 100k\Omega;$ see <b>Figure 50</b>	P_10.6.1
Bias reaction time	$t_{\rm RW_Bias}$	-	-	100	μs	V <sub>CANL/H</sub> = 0.5 V; see <b>Figure 51</b>	P_10.6.2



Figure 50 INH wake-up delay time







#### **Electrical Characteristics**

# **10.6.2** WUP detection Characteristics

#### Table 20 WUP detection

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol		Values	5	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Differential range dominant low power modes	V <sub>Diff_D_SLP_Ra</sub>	1.05	-	8.0	V	V <sub>CMR</sub> , Bus Biasing off <sup>1)</sup> ;	P_10.6.3
Differential range recessive low power modes	V <sub>Diff_R_SLP_Ra</sub>	-3.0	-	0.45	V	V <sub>CMR</sub> , Bus Biasing off <sup>1)</sup> ;	P_10.6.5
CAN activity filter time	t <sub>Filter</sub>	0.5	-	1.8	μs	-	P_10.6.8
Bus wake-up timeout	t <sub>wake</sub>	0.8	-	10.0	ms	-	P_10.6.9

1) Not subject to production test, specified by design.



### **Electrical Characteristics**

# 10.6.3 Local Wake-Up

## Table 21 Local Wake-Up

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Local wake-up detection threshold	V <sub>WAKE_TH</sub>	0.35 х V <sub>ват</sub>	0.5 х V <sub>ват</sub>	0.65 х <i>V</i> <sub>ВАТ</sub>	V	5.5 < V <sub>BAT</sub> < 32V	P_10.6.10
Local wake-up detection threshold	V <sub>WAKE_TH</sub>	0.25 х V <sub>ват</sub>	0.5 х V <sub>ват</sub>	0.75 х V <sub>ват</sub>	V	32 < V <sub>BAT</sub> < 40V	P_10.6.15
"high" level input current	I <sub>WAKE_H</sub>	-20	-	-	μΑ		P_10.6.12
"low" level input current	I <sub>WAKE_L</sub>	-	-	20	μΑ		P_10.6.13
Wake pulse filter time	t <sub>WAKE_Filter</sub>	10	-	50	μs	Figure 18 and Figure 19	P_10.6.14

## 10.7 SPI

## Table 22 SPI

Parameter	Symbol	Values			Unit	Note or	Number	
		Min.	Тур.	Max.		<b>Test Condition</b>		
SPI Clock Frequency						-		
SPI clock frequency	f <sub>spi</sub>	0.01	-	4.0	MHz	-	P_10.7.1	
Logic Input MOSI, SCLK	i			<u> </u>	L			
"high" level input voltage threshold	V <sub>H</sub>	-	0.5 x V <sub>IO</sub>	0.7 x V <sub>IO</sub>	V	-	P_10.7.2	
"low" level input voltage threshold	VL	0.3 x V <sub>IO</sub>	0.4 x V <sub>IO</sub>	-	V	-	P_10.7.3	
"high" level input current	I <sub>H</sub>	20	-	220	μΑ	$V_{MOSI} = V_{IO},$ $V_{SCLK} = V_{IO},$ pull-down;	P_10.7.5	
"low" level input current	IL.	-2.0	-	2.0	μA	$V_{\text{MOSI}} = 0 \text{ V},$ $V_{\text{SCLK}} = 0 \text{V};$	P_10.7.6	
Input capacitance	C <sub>IN</sub>	-	-	10	pF	1)	P_10.7.7	



## **Electrical Characteristics**

# Table 22SPI (cont'd)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Logic Input CSN		1	U	I			1
"high" level input voltage threshold	V <sub>H</sub>	-	0.5 x V <sub>IO</sub>	0.7 x V <sub>IO</sub>	V	-	P_10.7.21
"low" level input voltage threshold	VL	0.3 x V <sub>IO</sub>	0.4 x V <sub>IO</sub>	-	V	-	P_10.7.31
"high" level input current	I <sub>H</sub>	-2.0	-	2.0	μA	$V_{\rm CSN} = V_{\rm IO},$ pull-down;	P_10.7.33
"low" level input current	I <sub>L</sub>	-200	-	-20	μA	$V_{\rm CSN} = 0 \rm V;$	P_10.7.34
Input capacitance	C <sub>IN</sub>	-	-	10	pF	1)	P_10.7.35
Logic Output: MISO							+
"high" level output current	I <sub>MISO_H</sub>	-	-	-1.0	mA	$V_{\rm MISO} = V_{\rm IO} - 0.4 \rm V;$	P_10.7.8
"low" level output current	I <sub>MISO_L</sub>	1	-	-	mA	$V_{\rm MISO} = 0.4 \rm V;$	P_10.7.9
Rise time	t <sub>MISO_R</sub>	-	-	80.0	ns	$30\% - 70\% \text{ of } V_{IO},$ $C_{MISO} = 100 \text{ pF};$	P_10.7.10
Fall time	t <sub>MISO_F</sub>	-	-	80.0	ns	70% - 30% of $V_{\rm IO}$ , $C_{\rm MISO}$ = 100 pF;	P_10.7.11
Difference of rise and fall time	$ t_{MISO_R} - t_{MISO_F} $	-	-	10.0	ns	С <sub>мізо</sub> = 100 рF;	P_10.7.12
"tri-state" leakage current	I <sub>MISO_Tri</sub>	-10.0	-	10.0	μA	$0 < V_{\rm MISO} < V_{\rm IO};$	P_10.7.13
"tri-state" Input capacitance		-	-	10	pF	1)	P_10.7.14
SPI data timing <sup>1)</sup>			1		4		4
Clock "high" period	t <sub>SCLK_H</sub>	125	-	-	ns	-	P_10.7.15
Clock "low" period	t <sub>SCLK_L</sub>	125	-	-	ns	-	P_10.7.16
Clock "low" before CSN "low"	t <sub>bef</sub>	125	-	-	ns	-	P_10.7.17
CSN setup time	t <sub>lead_NM</sub>	1	-	-	μs	Normal-operating Mode, Stand-by Mode, Receive- only Mode;	P_10.7.18
CSN setup time	t <sub>lead_SP</sub>	6.0	-	-	μs	Selective Wake Sub-Mode, Selective Sleep Sub-Mode, Sleep WUP Mode;	P_10.7.19
SCLK setup time	t <sub>lag</sub>	250	-	-	ns	-	P_10.7.20
MOSI setup time	t <sub>MOSI_SU</sub>	25	_	_	ns	-	P_10.7.22
MOSI hold time	t <sub>MOSI_HO</sub>	50	_	_	ns	-	P_10.7.23
CSN "high" time	t <sub>CSN_H</sub>	3.0	_	_	μs	_	P_10.7.24



## **Electrical Characteristics**

## Table 22SPI (cont'd)

4.75 V <  $V_{CC}$  < 5.25 V; 3.0 V <  $V_{IO}$  < 5.5 V; 5.5V <  $V_{BAT}$  < 40V;  $R_L$  = 60  $\Omega$ ; -40 °C <  $T_J$  < 150 °C; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Maximum signal rise time on SPI inputs: MOSI, SCLK and CSN	t <sub>R_max</sub>	-	-	50	ns	-	P_10.7.25
Maximum signal fall time on SPI inputs: MOSI, SCLK and CSN	t <sub>F_max</sub>	-	-	50	ns	-	P_10.7.26
MISO enable time	t <sub>MISO_EN</sub>	-	-	120	ns	-	P_10.7.27
MISO enable time in Sleep Mode	t <sub>miso_en_slp</sub>	-	-	5.5	μs	-	P_10.7.36
MISO disable time	t <sub>MISO_DIS</sub>	-	-	50	ns	-	P_10.7.28
MISO valid time	t <sub>MISO_VAL</sub>	-	-	100	ns	-	P_10.7.29
CSN Timeout	t <sub>csn_to</sub>	2.1	-	4	ms	-	P_10.7.30

1) Not subject to production test, specified by design.



Figure 52 SPI timings



**Application Information** 

# **11** Application Information

# **11.1 ESD Robustness according to IEC 61000-4-2**

Tests for ESD robustness according to IEC61000-4-2 "Gun test" (150 pF, 330  $\Omega$ ) have been performed. The results and test conditions are available in a separate test report.

## Table 23 ESD robustness according to IEC61000-4-2

Performed Test	Result	Unit	Remarks
Electrostatic discharge voltage at pin V <sub>BAT</sub> , CANH, CANL and WAKE <sup>1)</sup> versus GND	≥ +10	kV	<sup>2)</sup> Positive pulse
Electrostatic discharge voltage at pin V <sub>BAT</sub> , CANH, CANL and WAKE <sup>1)</sup> versus GND	≤ -10	kV	<sup>2)</sup> Negative pulse

1) 10 nF capacitor and 3.3 k $\Omega$  resistor required (see Figure 53).

2) ESD susceptibility "ESD GUN" according to GIFT / ICT paper: "EMC Evaluation of CAN Transceivers, IEC TS 62228", section 4.3. (DIN EN 61000-4-2)

Tested by external test facility (IBEE Zwickau, EMC test report).



**Application Information** 

# **11.2** Application Example



Figure 53 Application circuit



## **Application Information**

# **11.3** Voltage Adaption to the Microcontroller Supply

To adapt the digital input and output levels of the TLT9255W to the I/O levels of the microcontroller, connect the power supply pin  $V_{10}$  to the microcontroller voltage supply (see **Figure 53**).

Note: In case the digital supply voltage  $V_{IO}$  is not required in the application, connect the digital supply voltage  $V_{IO}$  to the transmitter supply  $V_{CC}$ .

# **11.4** Further Application Information

- Please contact us for information regarding the pin FMEA.
- For further information you may visit: www.infineon.com/automotive-transceiver



Package Outlines

# 12 Package Outlines



## Figure 54 PG-TSON-14

## **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on alternative packages, please visit our website: http://www.infineon.com/packages.



**Revision History** 

# 13 Revision History

Revision	Date	Changes
1.0	2019-10-08	Initial datasheet

#### Trademarks

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